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Krabbenborg

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(54) **CIRCUIT FOR A SWITCHED MODE POWER SUPPLY**

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H03F 3/45 (2006.01)
G05F 1/10 (2006.01)
H02M 1/00 (2006.01)

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CPC *H02M 3/156* (2013.01); *G05F 1/10* (2013.01); *H02M 1/40* (2013.01); *H03F 3/45071* (2013.01); *H02M 2001/0006* (2013.01); *H02M 2001/0009* (2013.01); *H02M 2001/0025* (2013.01)

(58) **Field of Classification Search**
None
See application file for complete search history.

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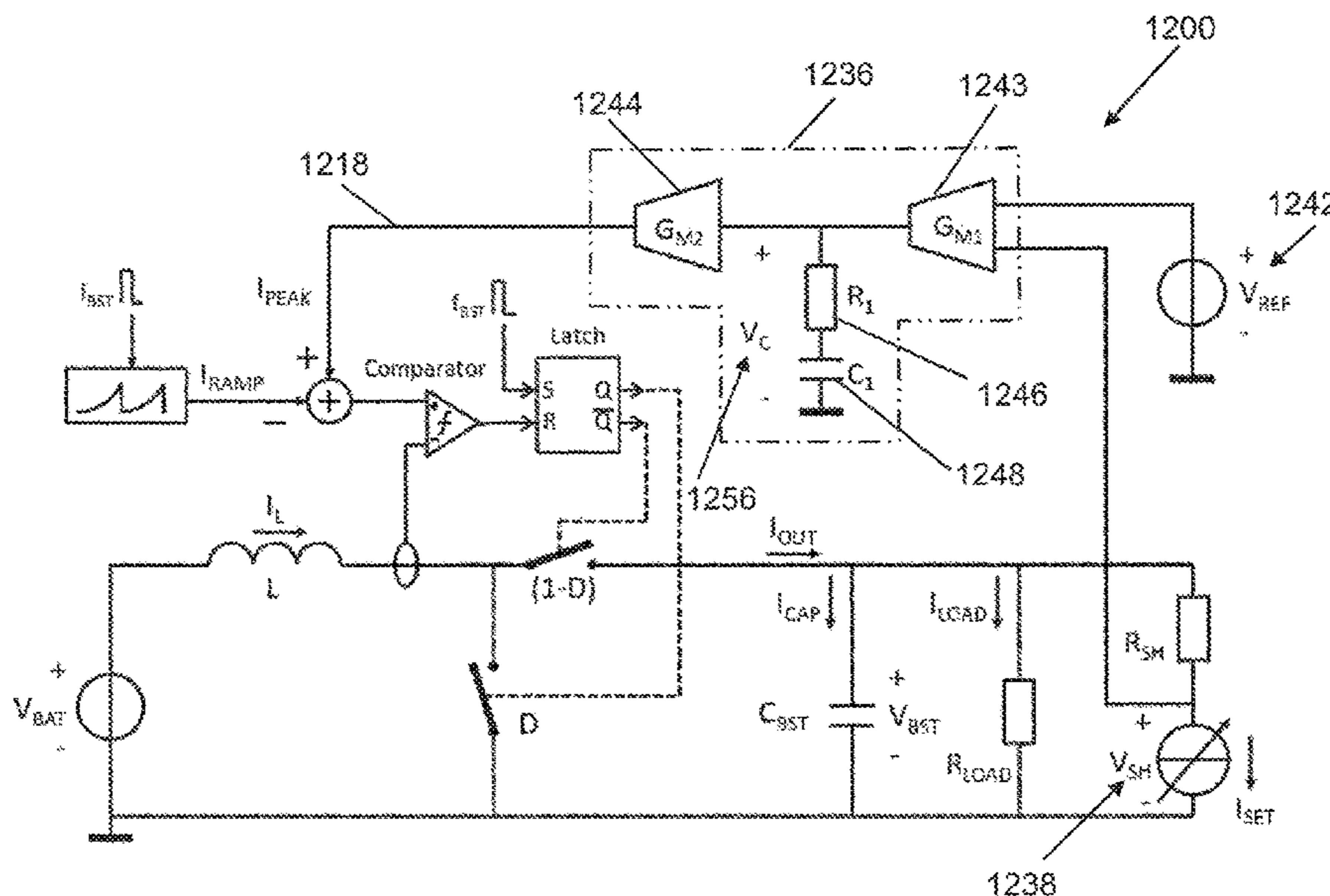
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Primary Examiner — Jeffrey A Gblende

(57) **ABSTRACT**

A circuit for a switched-mode-power-supply. The switched-mode-power-supply is configured to: receive a current-control-signal; and provide an output-voltage based on the current-control-signal. The circuit comprises a controller, a current-limiter and a clamp-circuit. The controller is configured to: generate a control-voltage based on the difference between: (i) a sense-voltage, which is representative of the output-voltage of the switched-mode-power-supply; and (ii) a reference-voltage; generate a target-current-control-signal based on the control-voltage, wherein the target-current-control-signal is configured to adjust the current through the switched-mode-power-supply in order to bring the sense-voltage closer to the reference-voltage. The current-limiter is configured to provide the current-control-signal as the target-current-control-signal limited to a max-current-control-value. The clamp-circuit is configured to set the control-voltage to a clamp-voltage-value when the current-limiter provides the current-control-signal having the limited value of the max-current-control-value.

16 Claims, 15 Drawing Sheets



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Figure 1

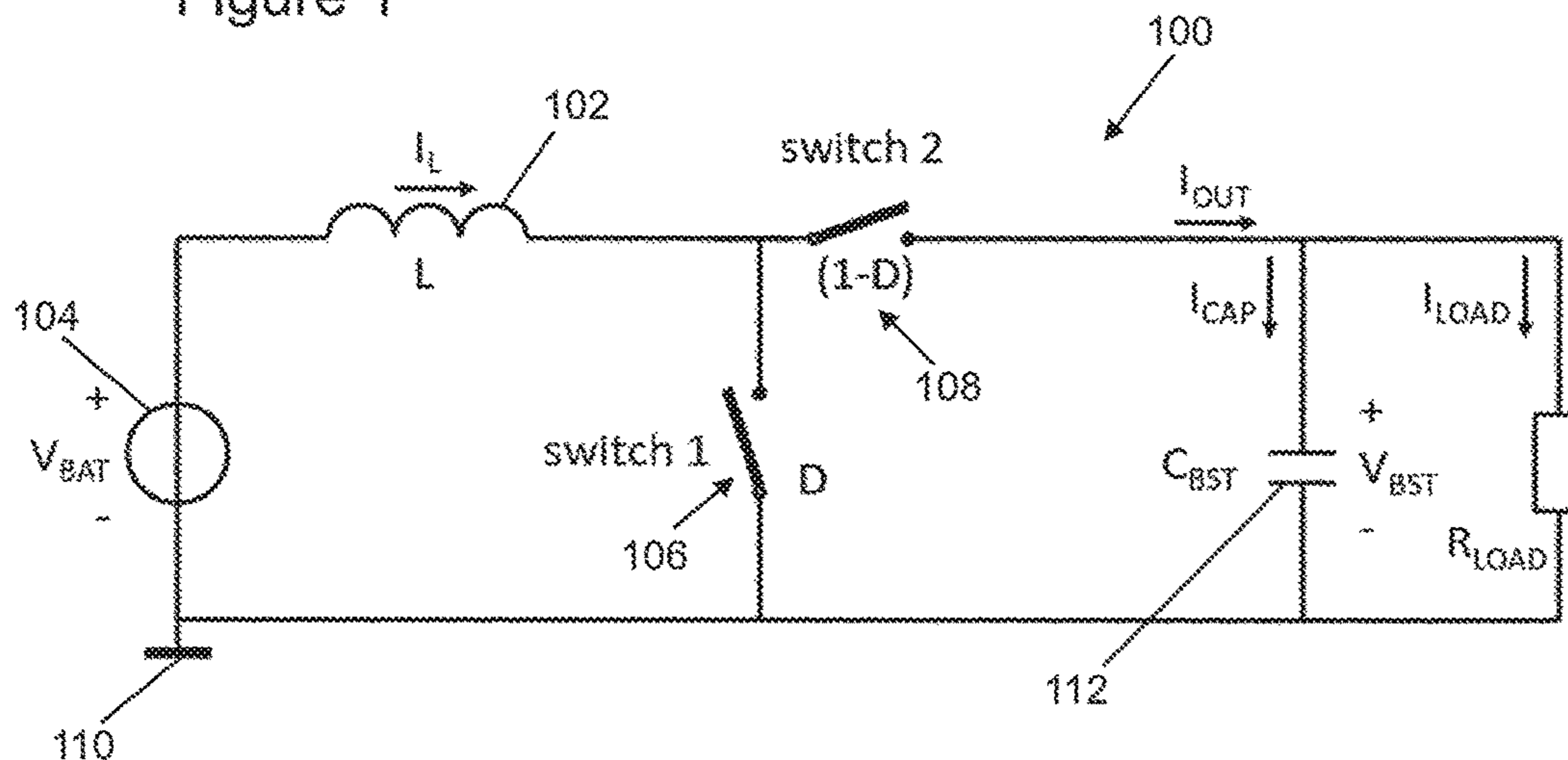


Figure 2

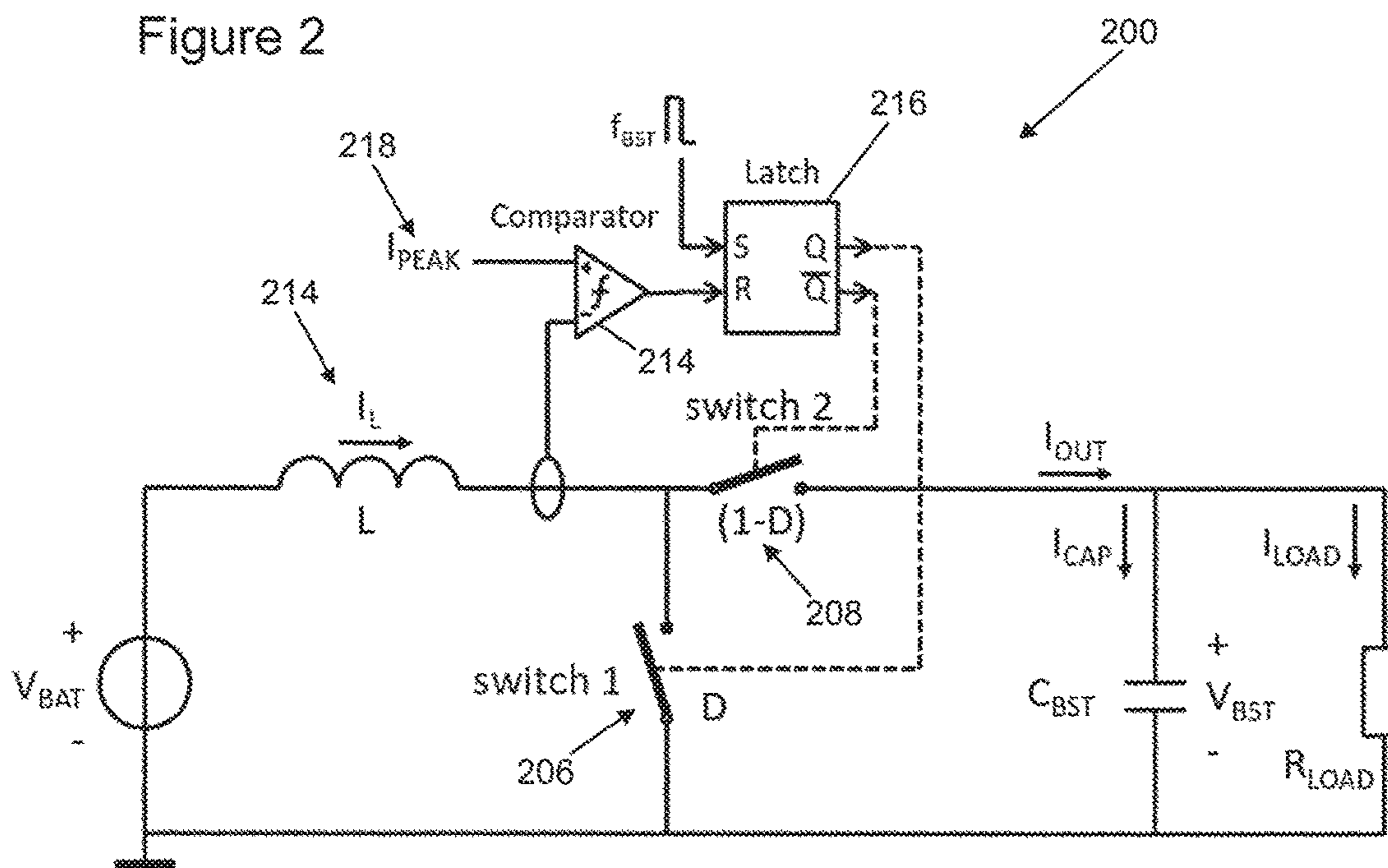


Figure 3

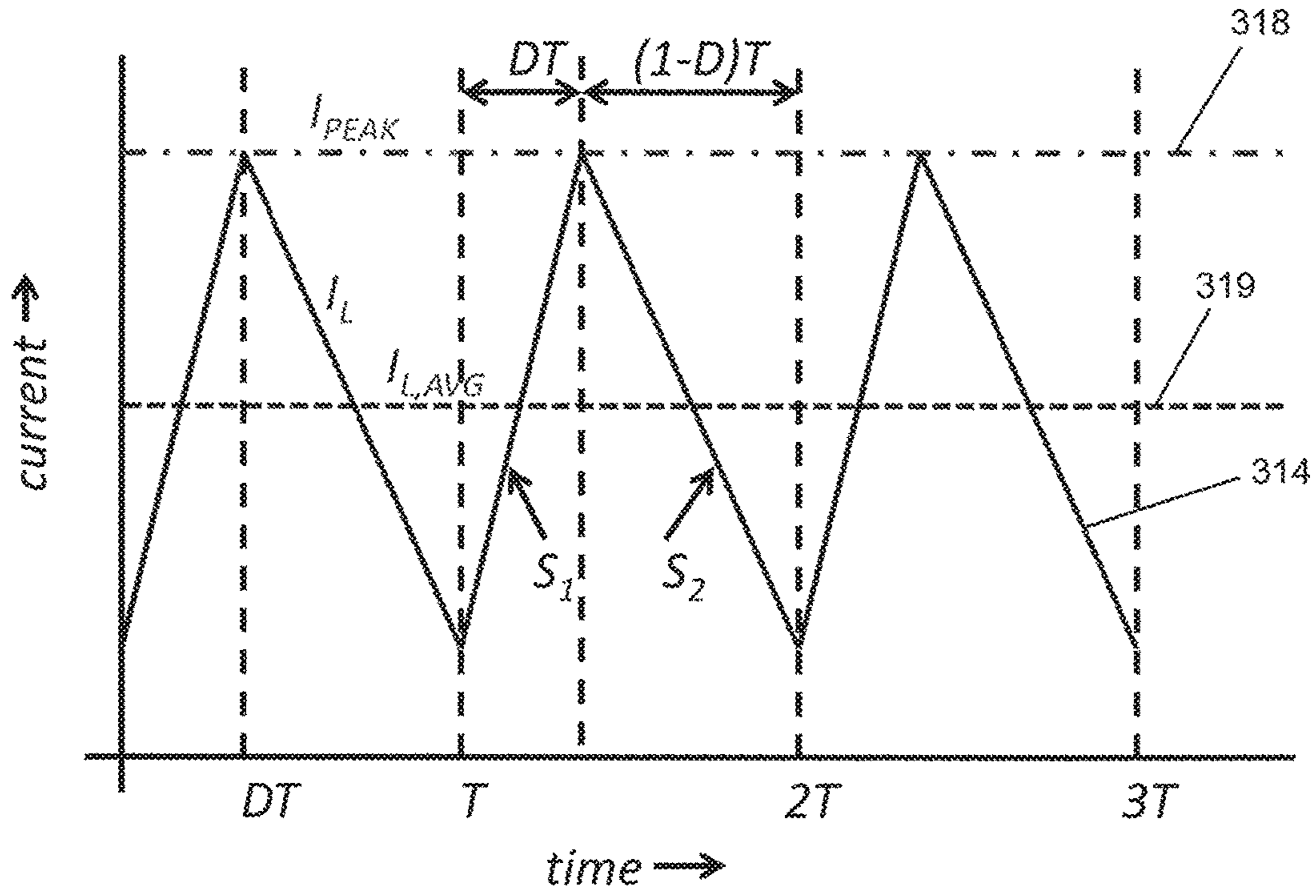


Figure 4

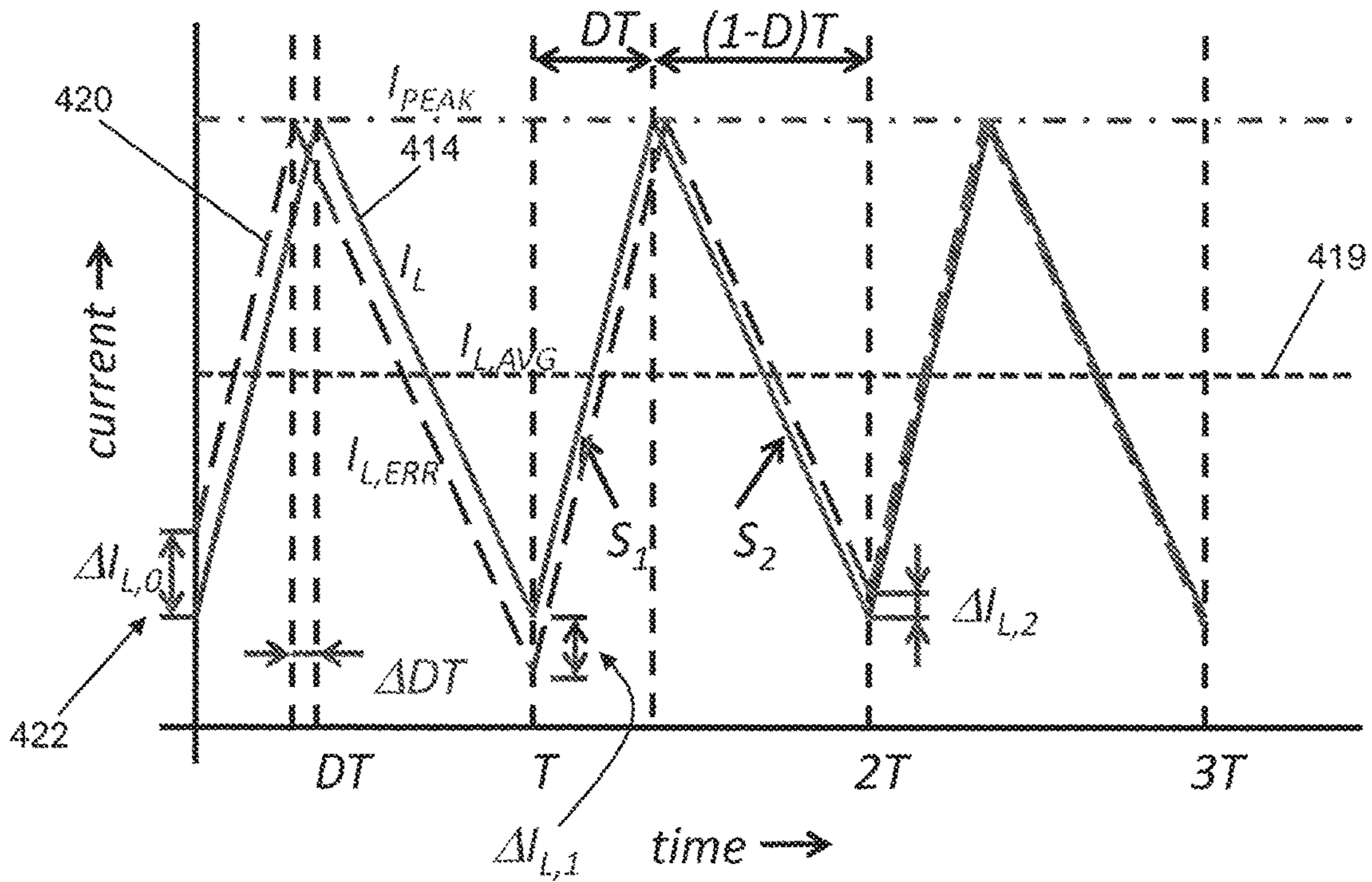


Figure 5

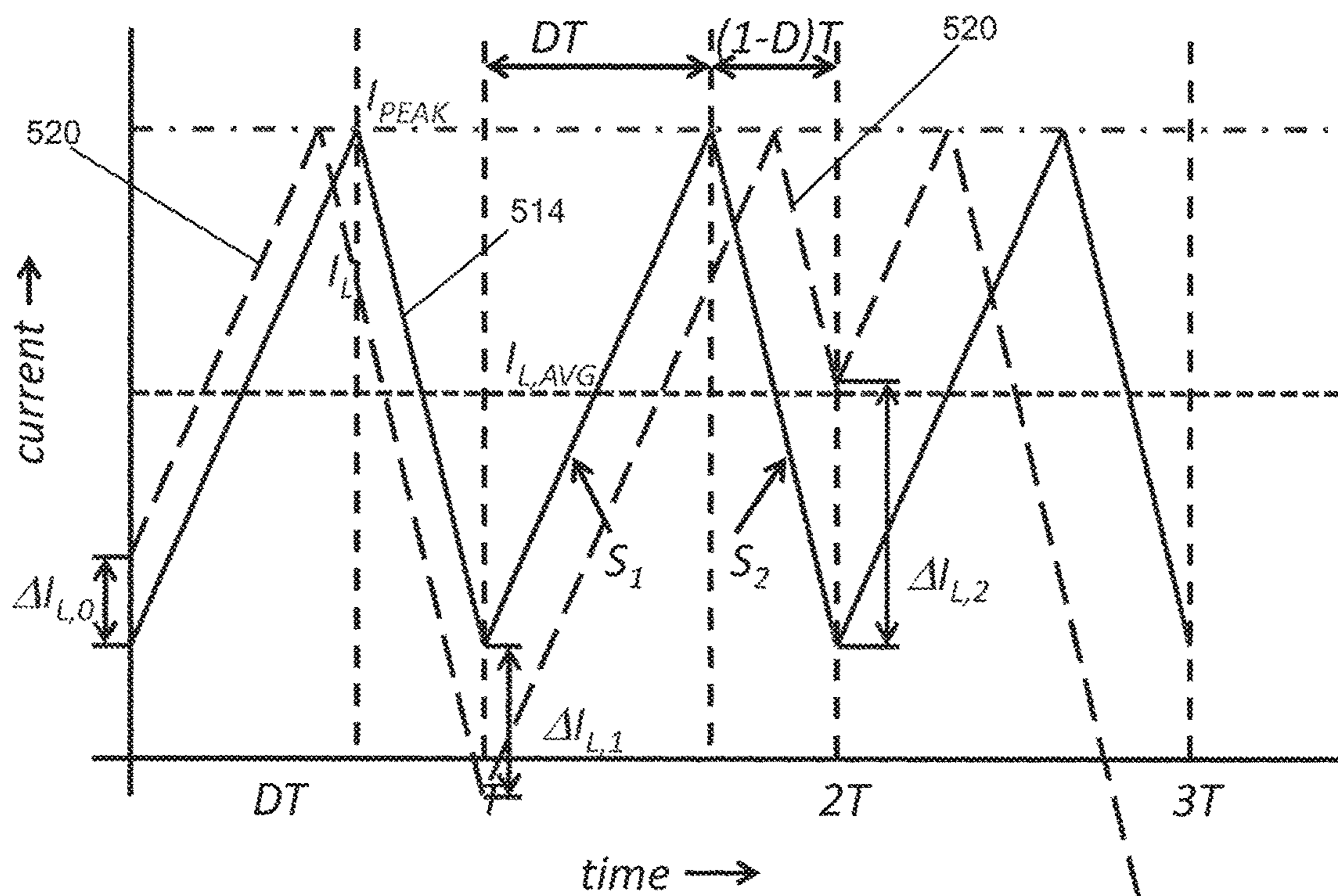


Figure 6

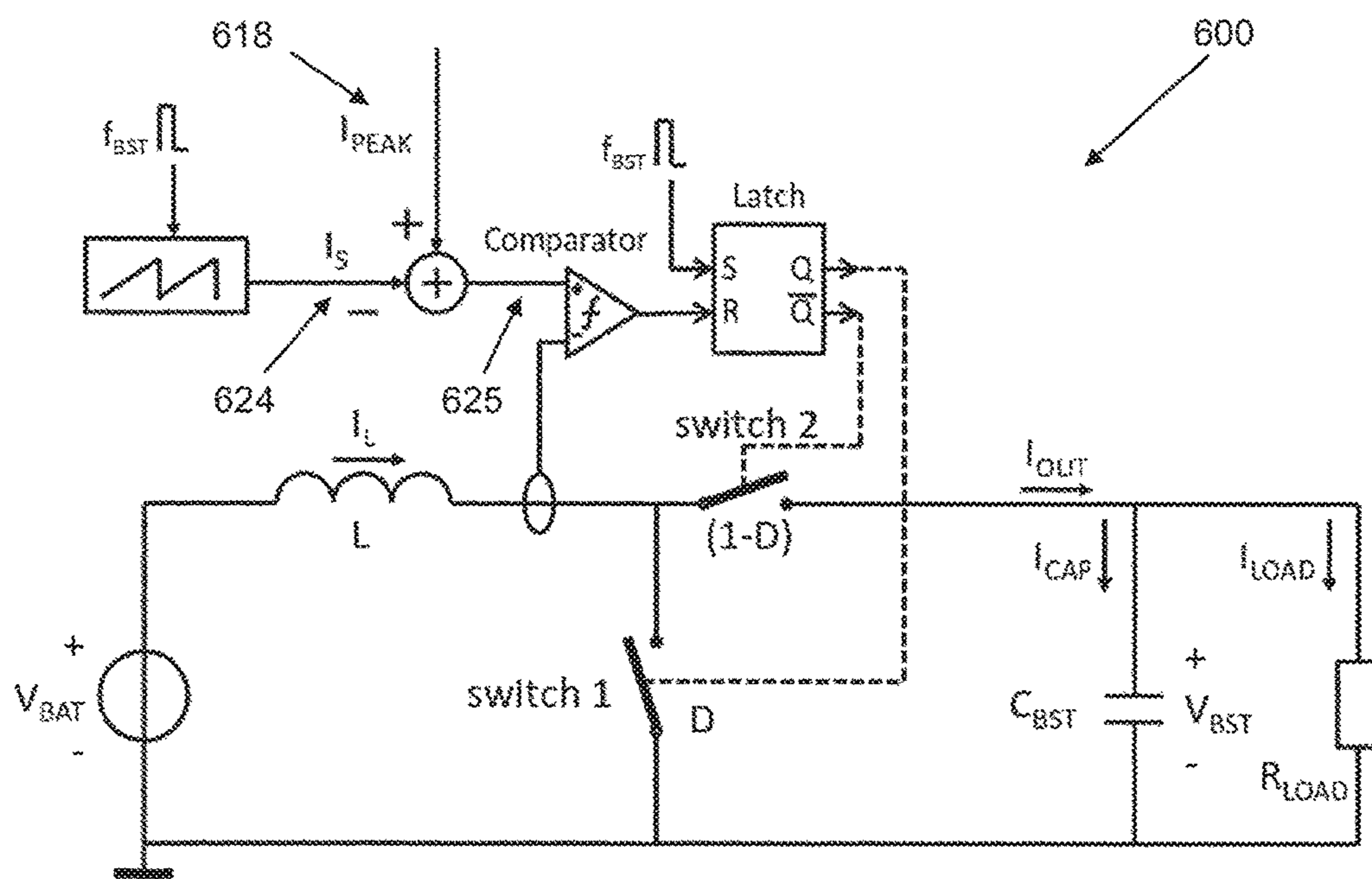


Figure 7

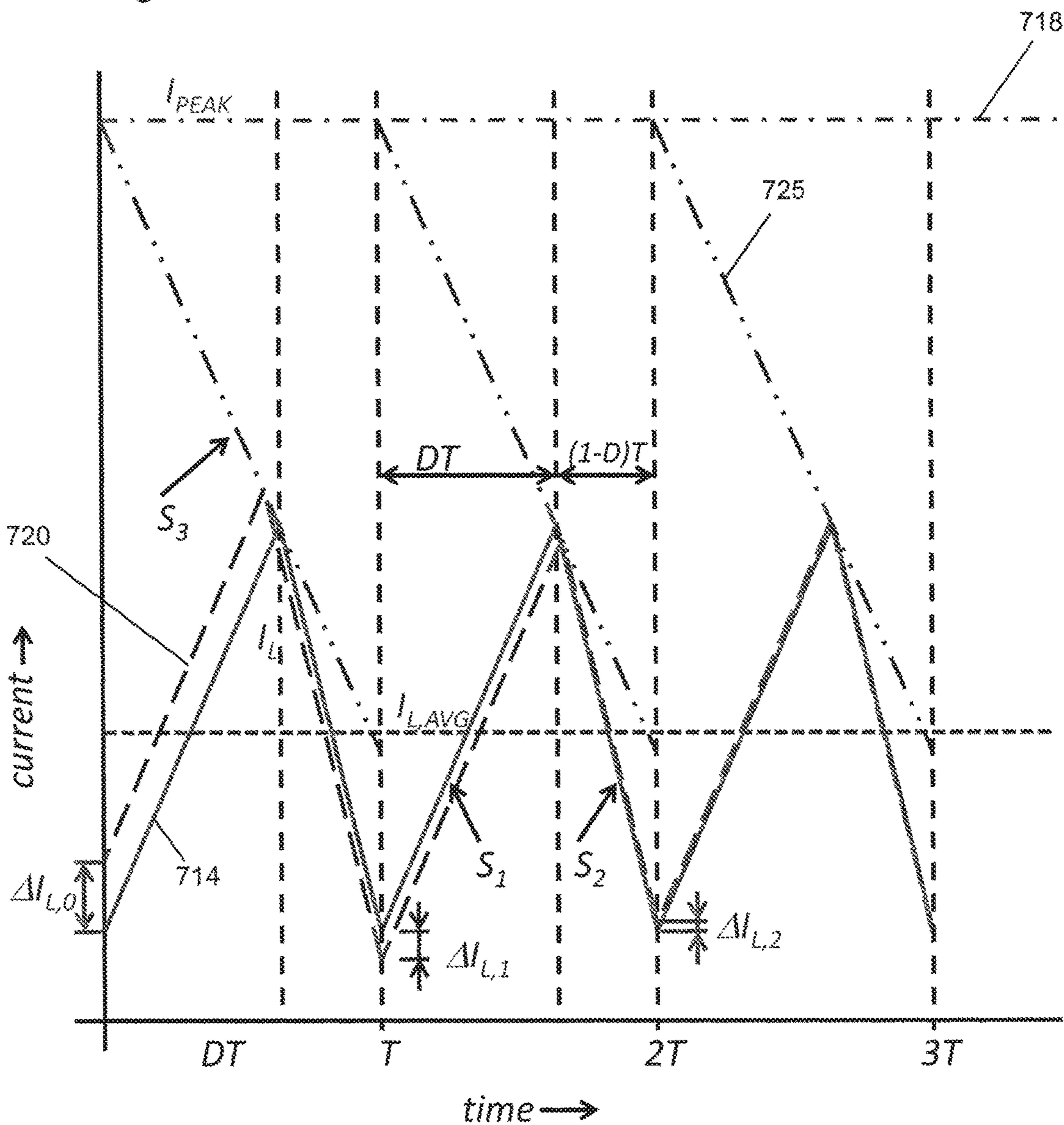


Figure 8

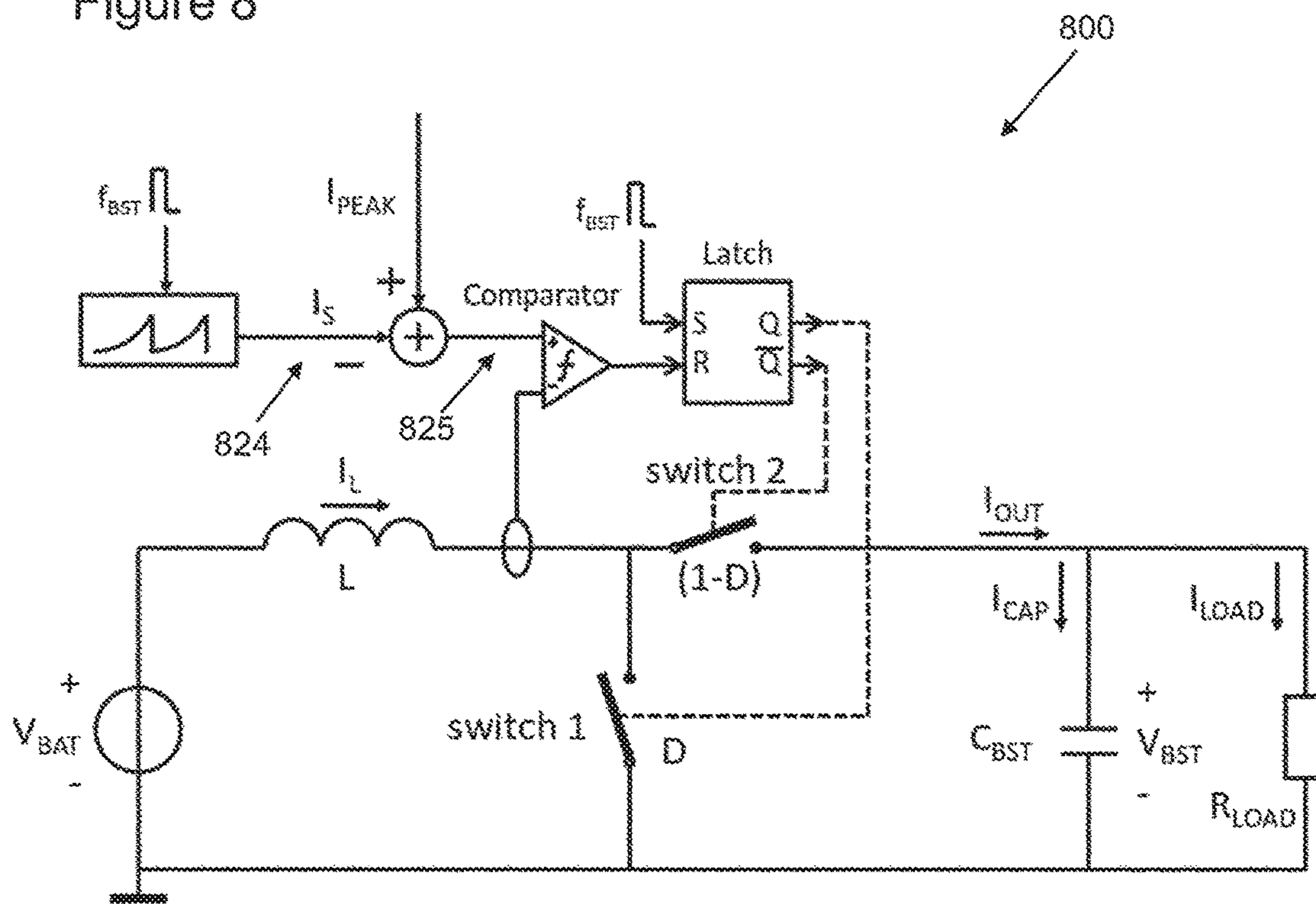


Figure 9

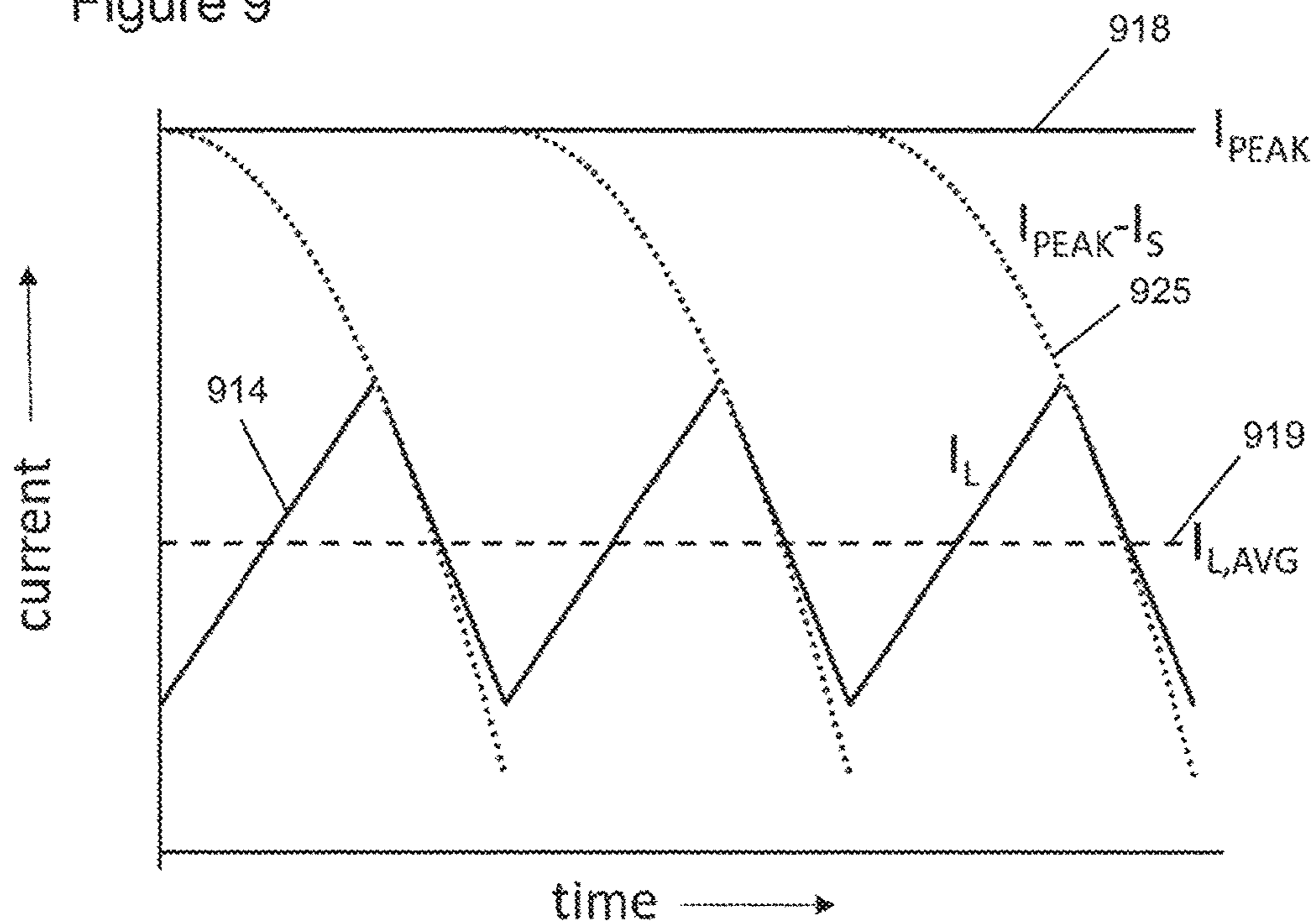


Figure 10

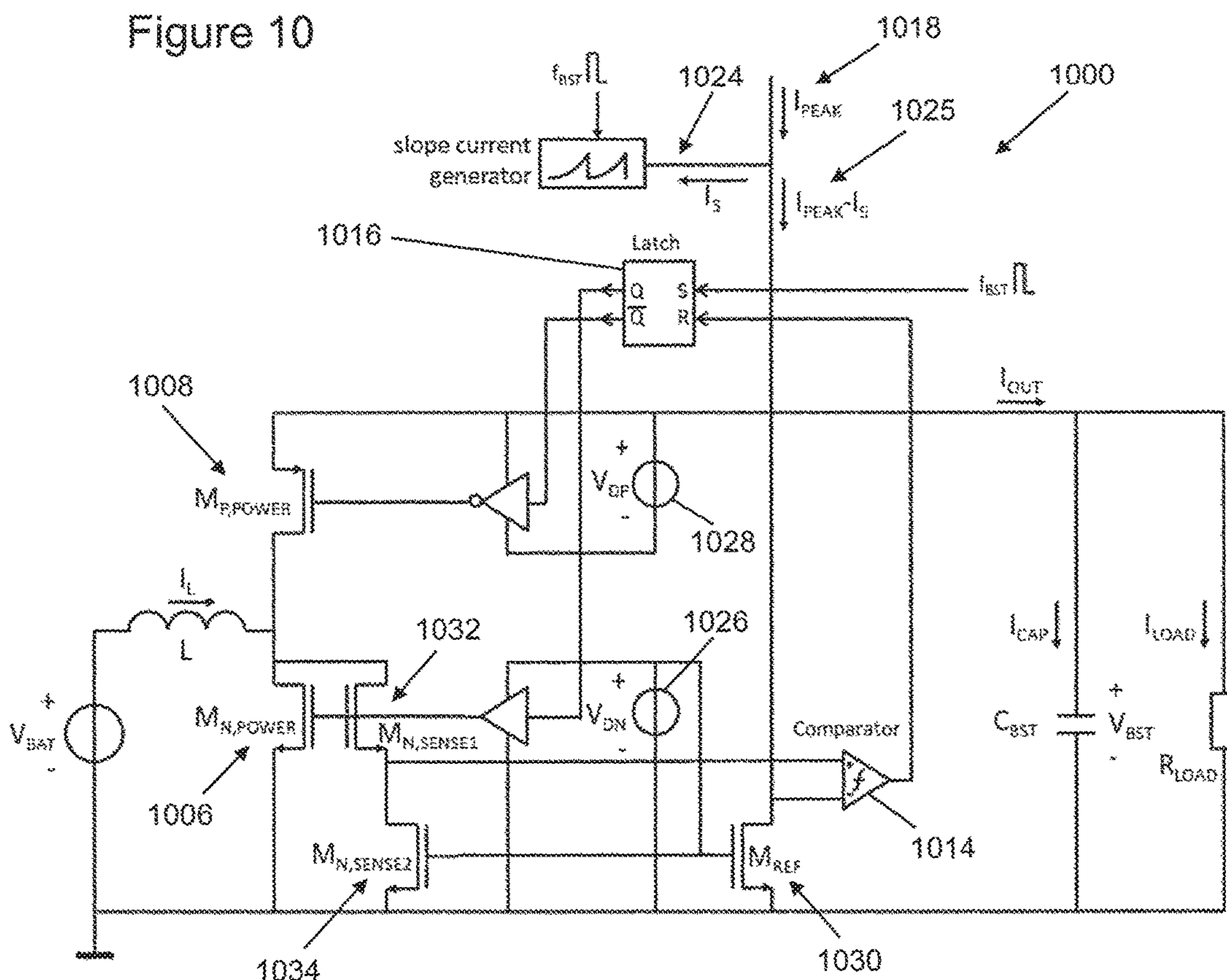
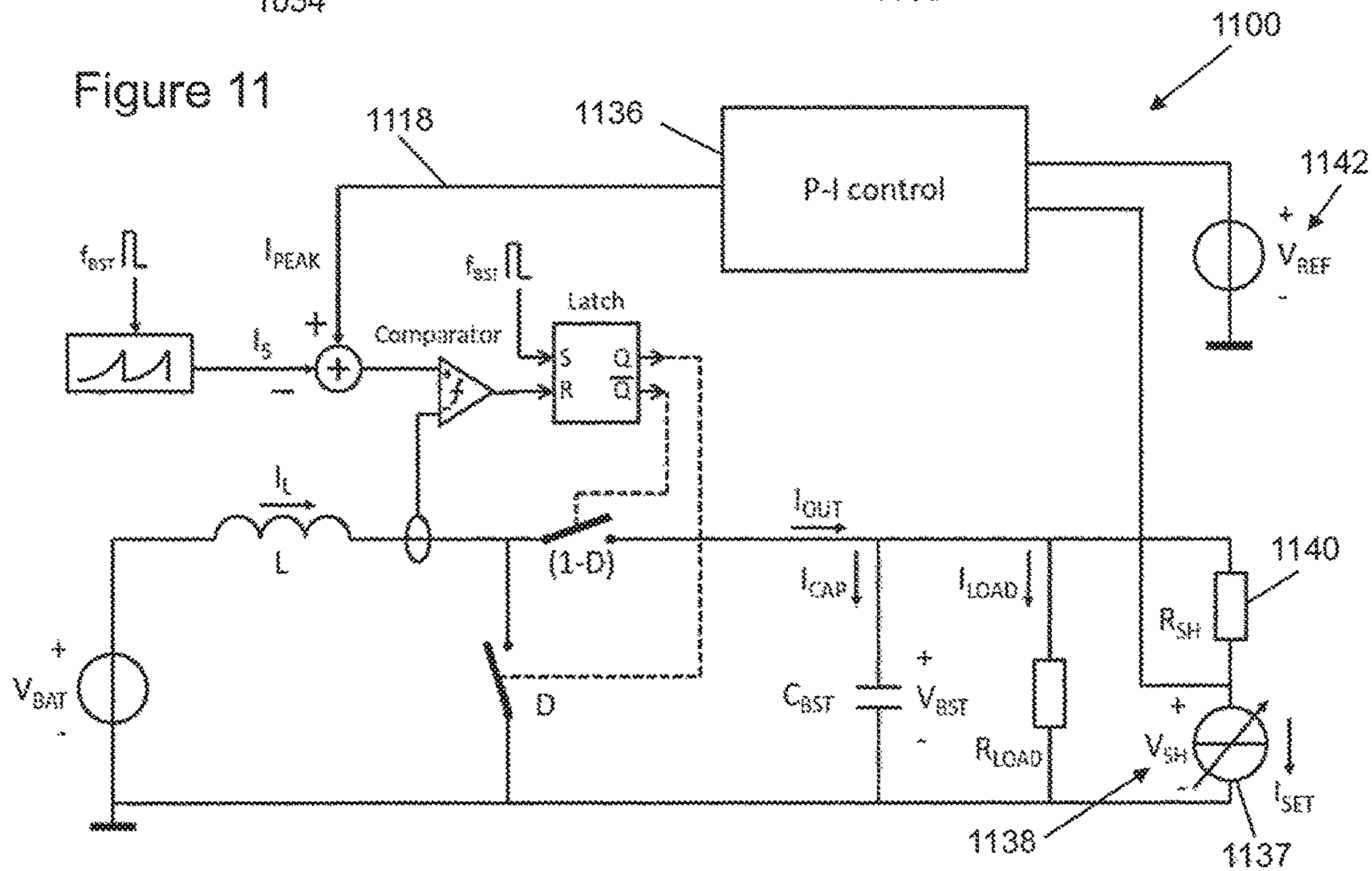
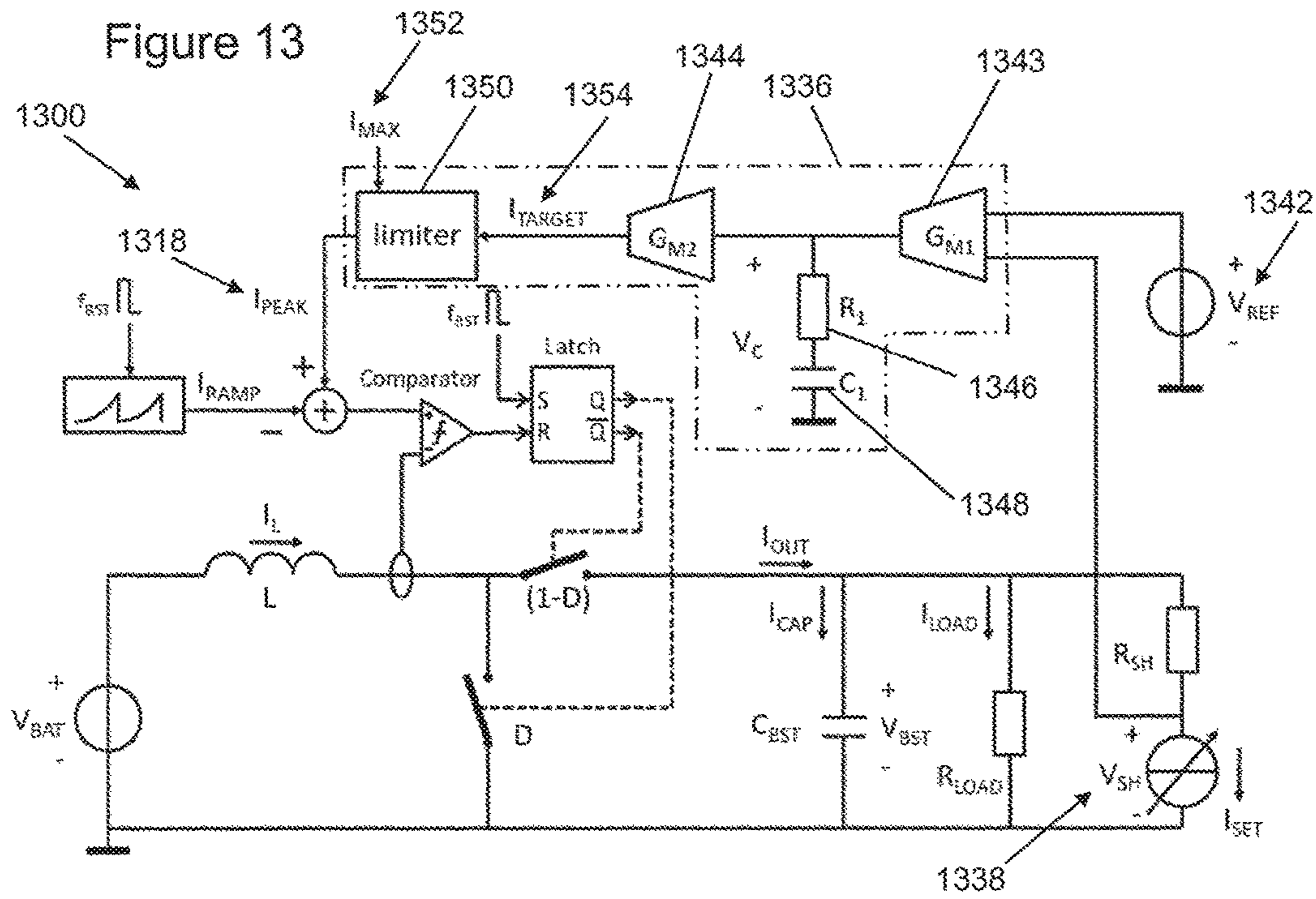
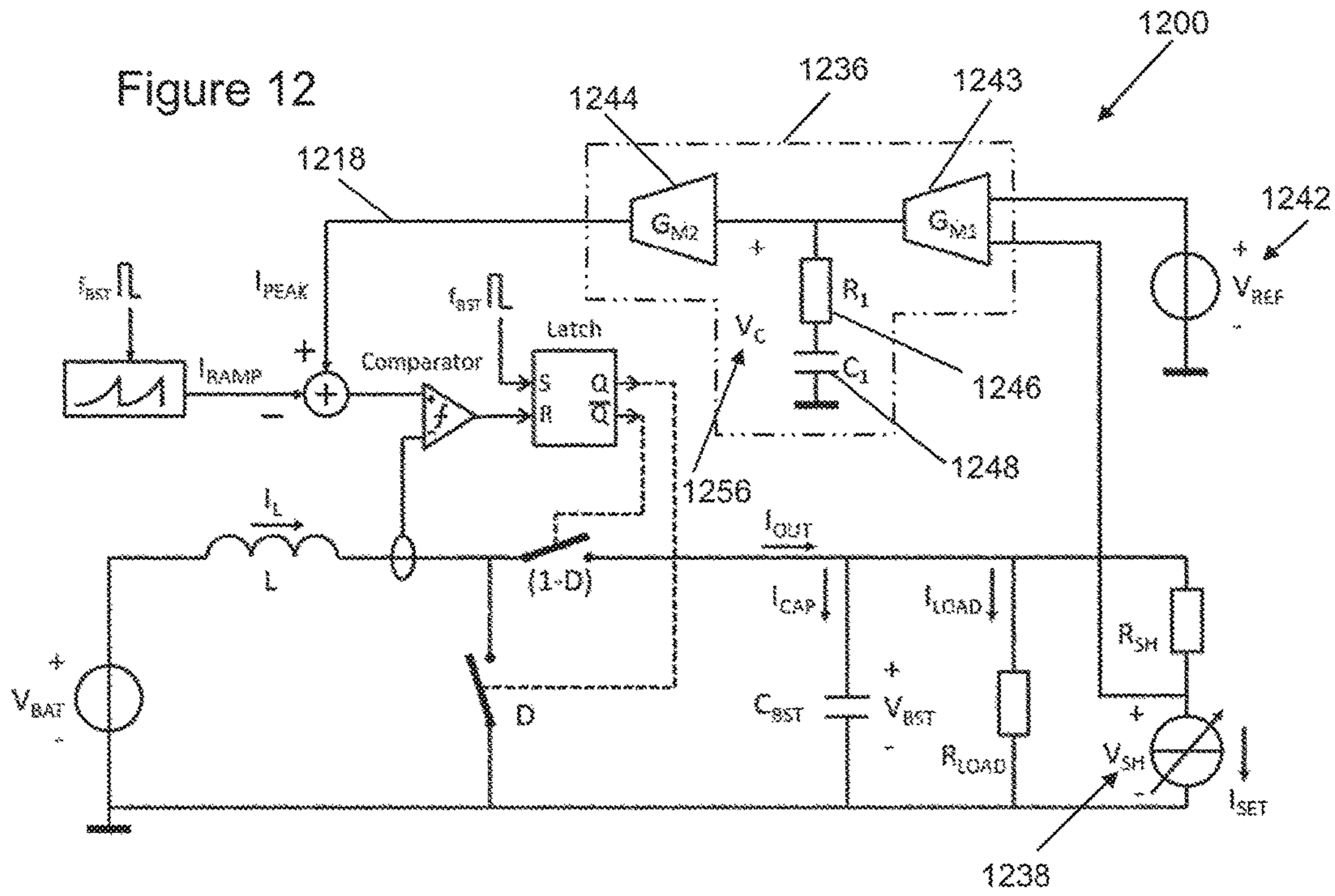


Figure 11





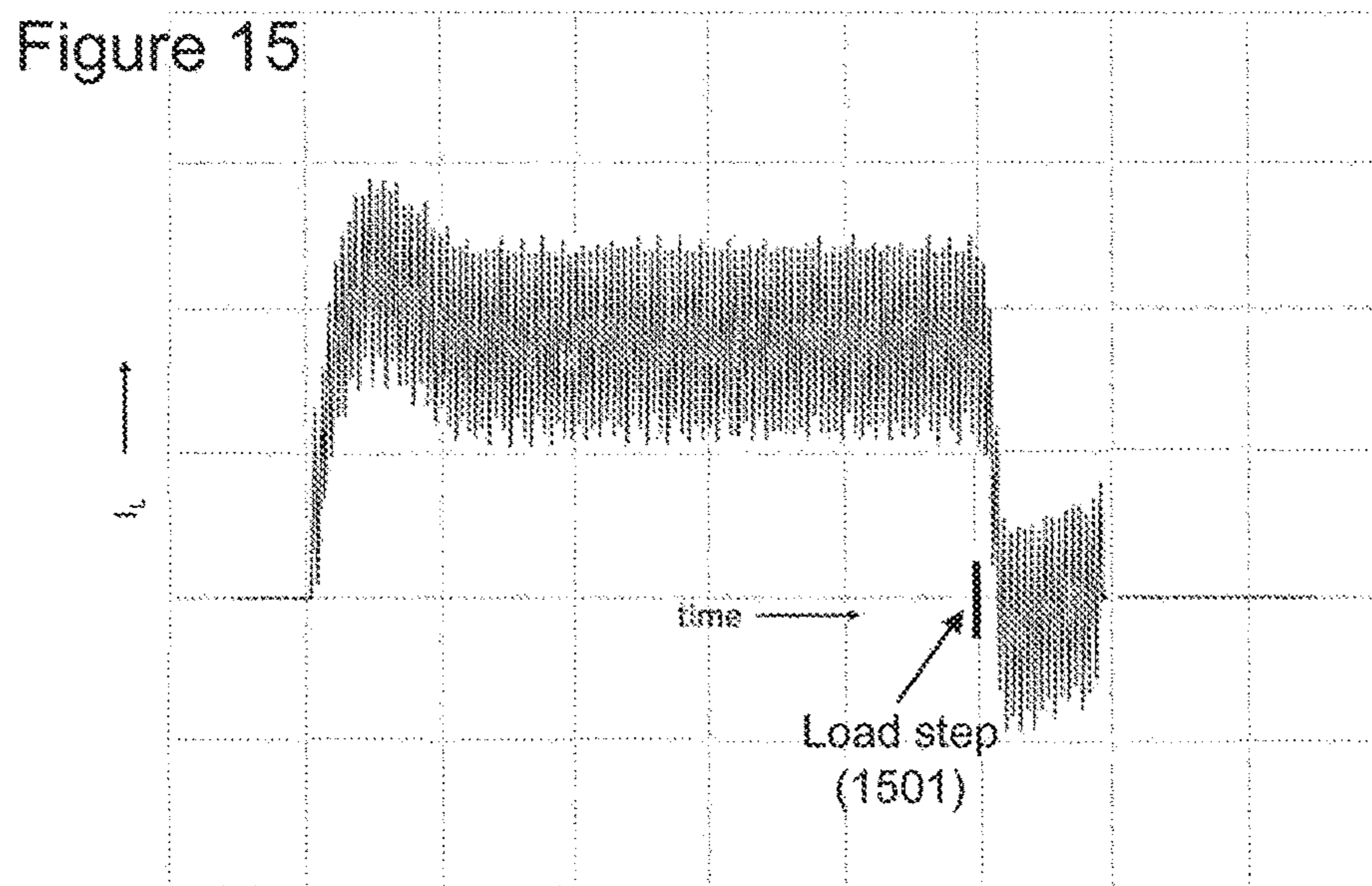
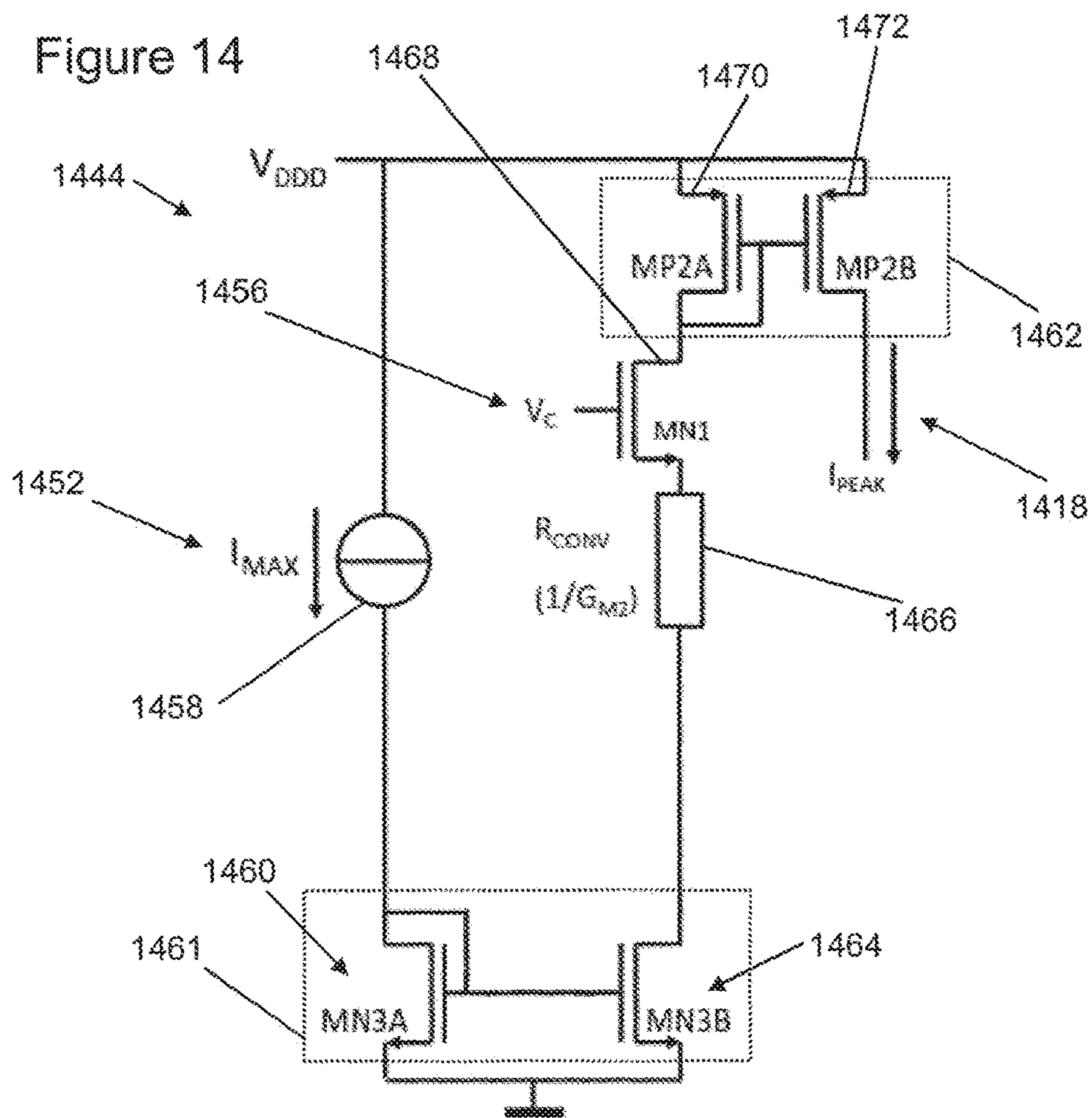


Figure 16

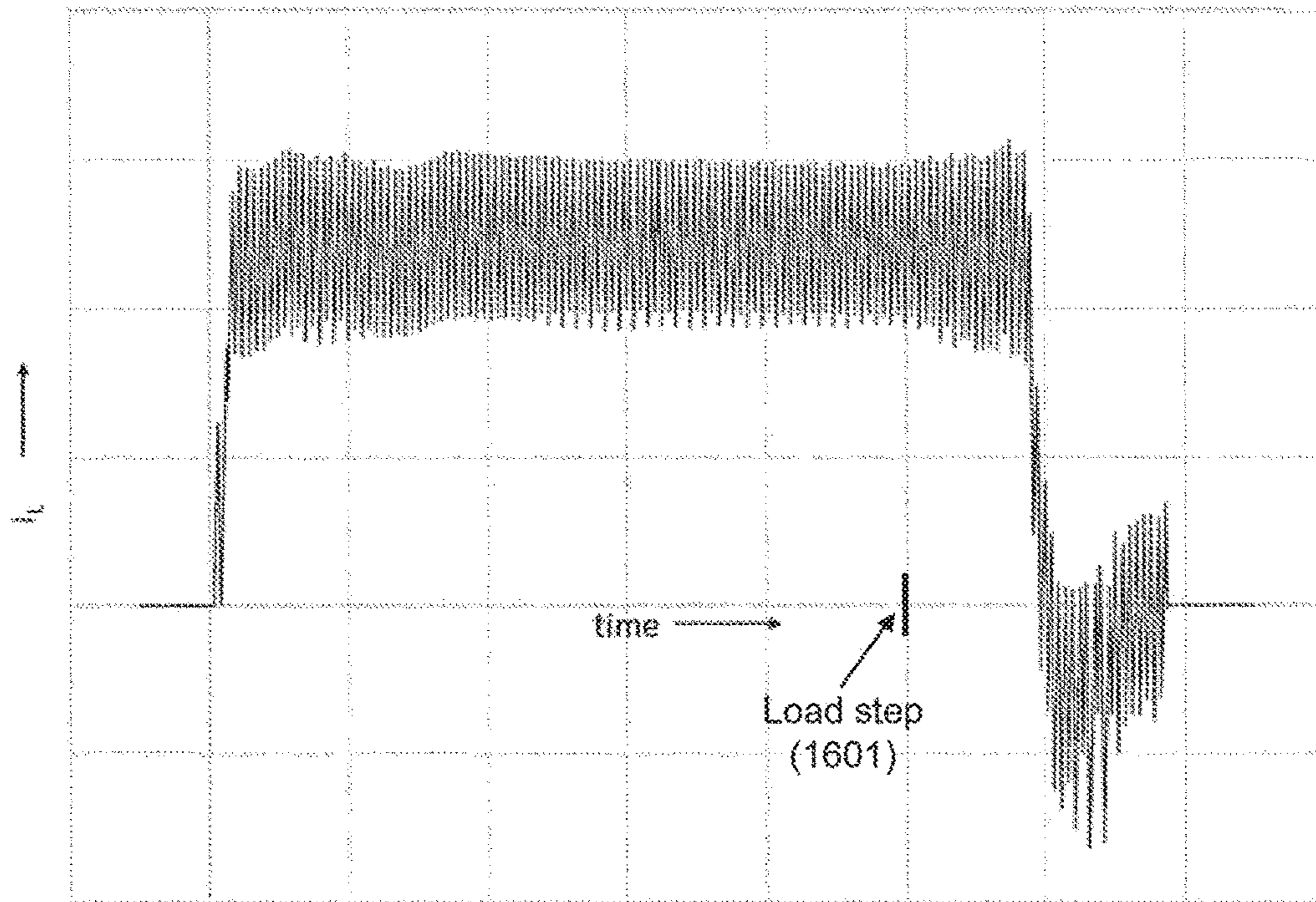


Figure 17

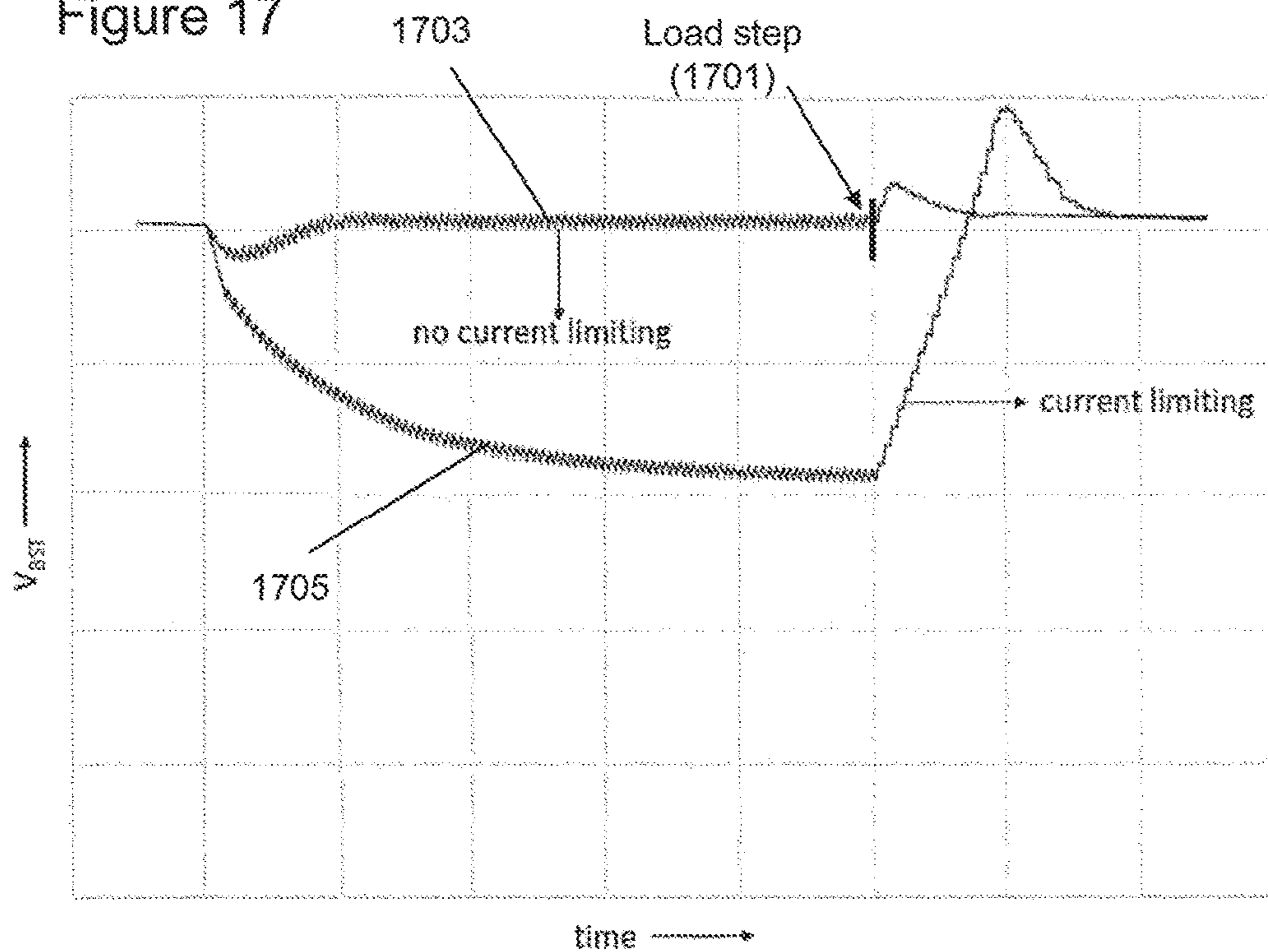


Figure 18

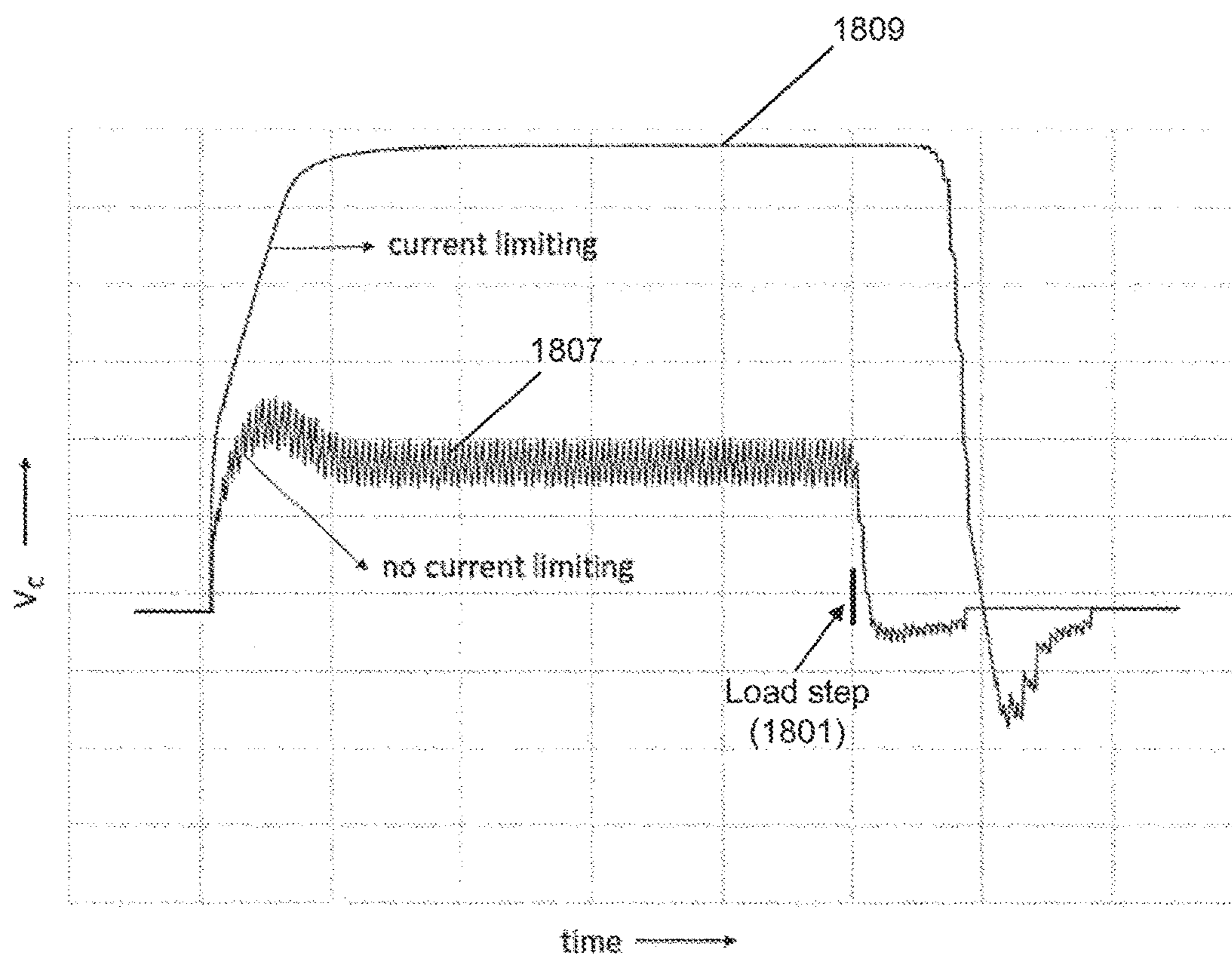


Figure 19

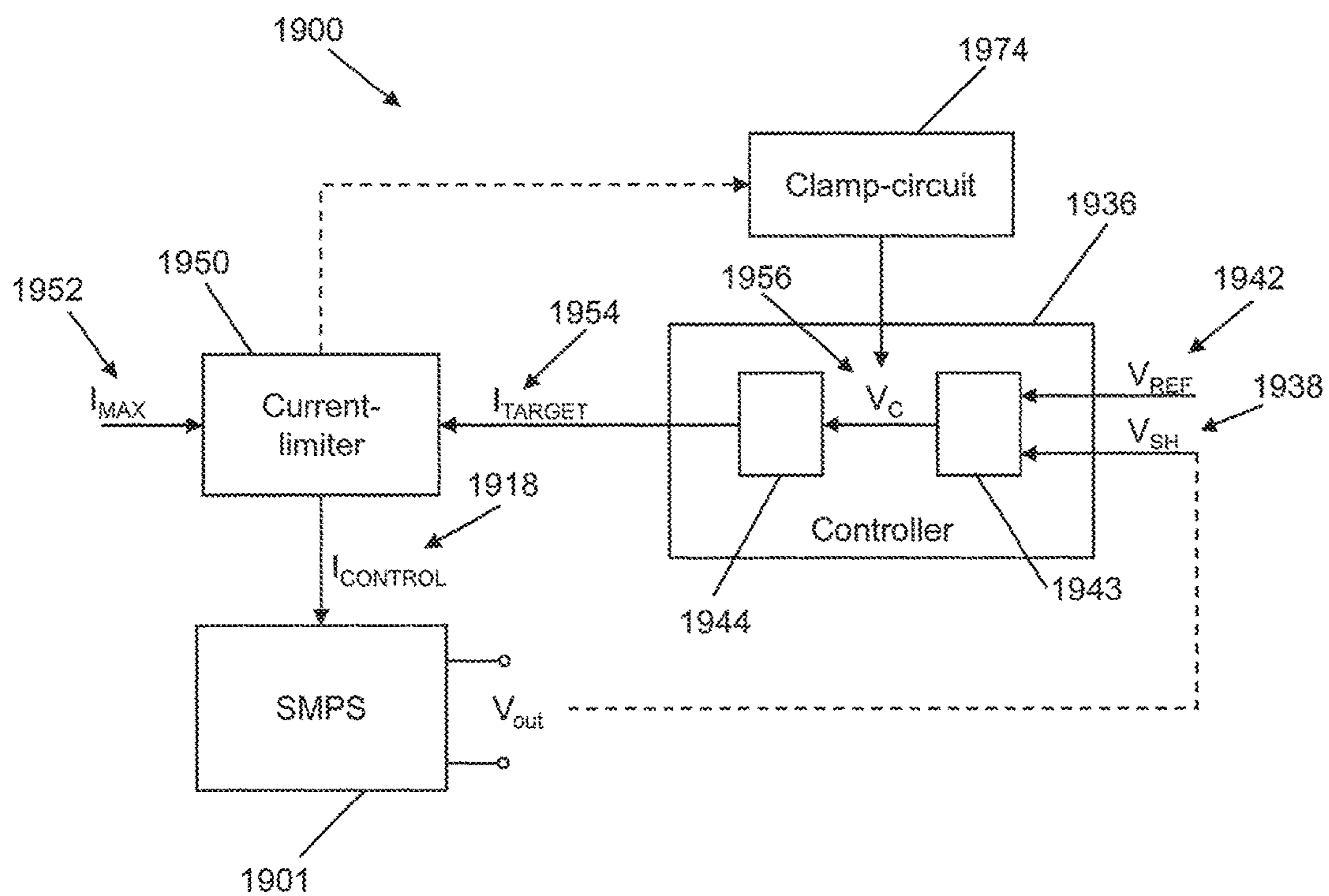


Figure 20

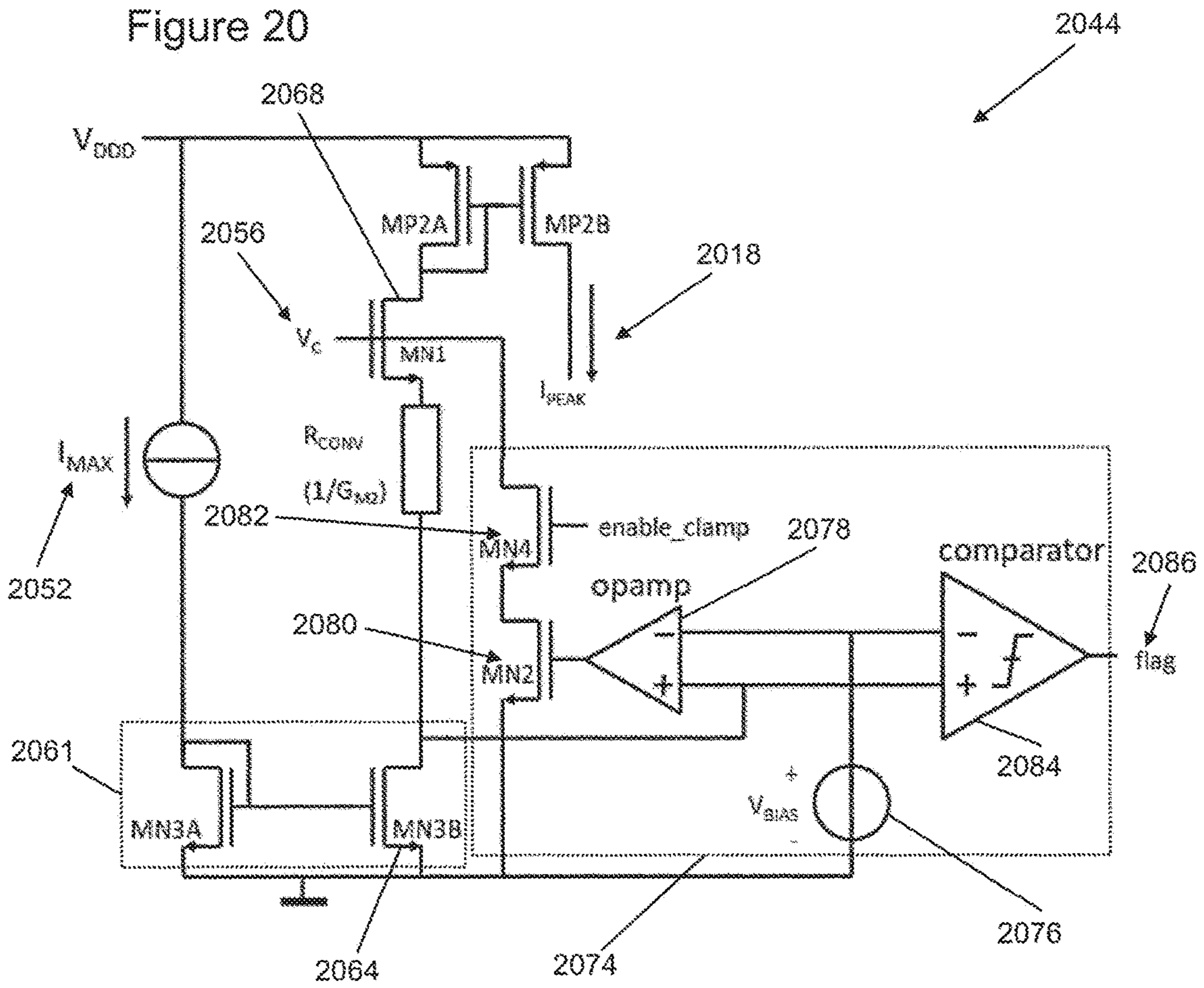


Figure 21

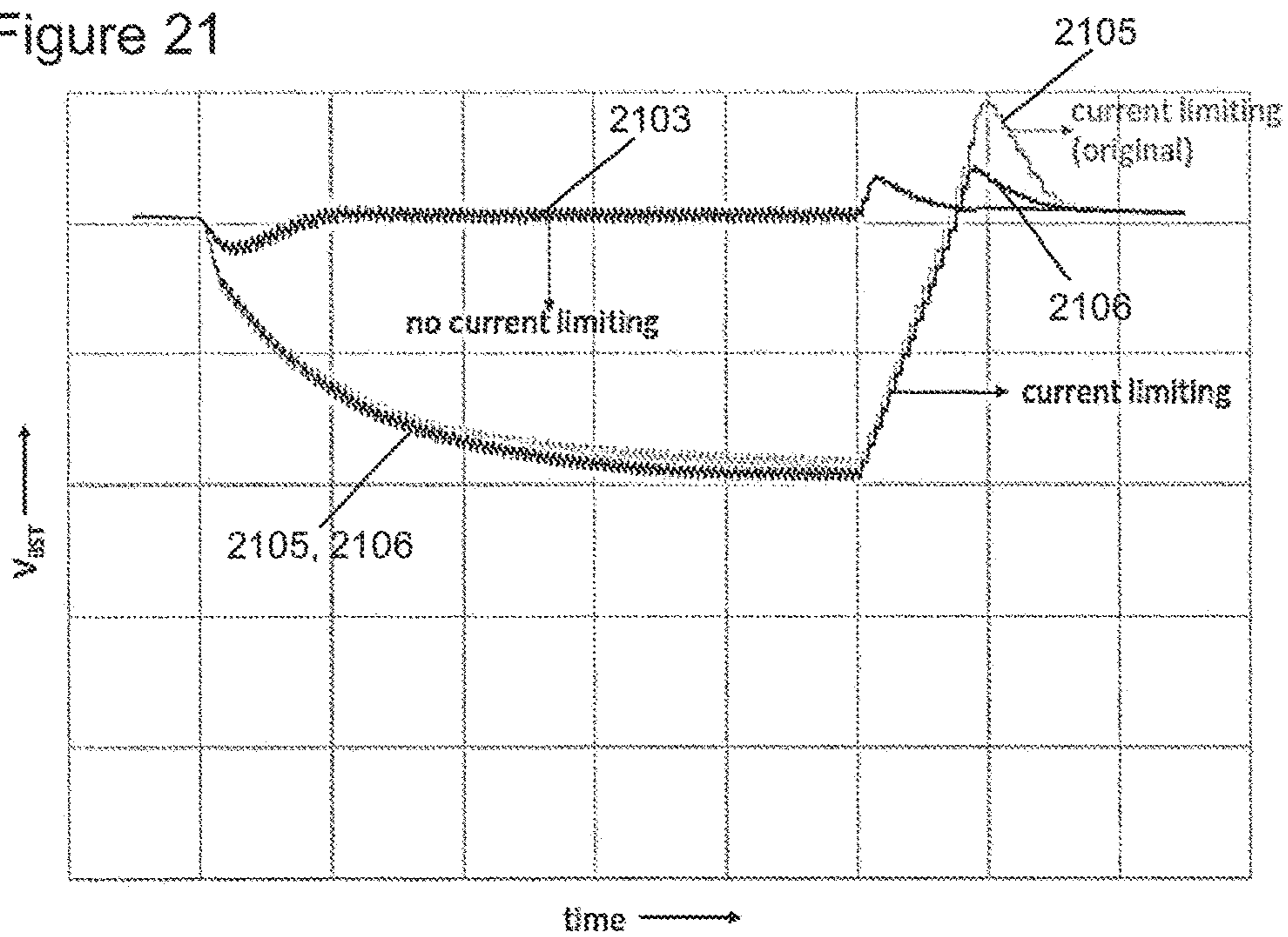


Figure 22

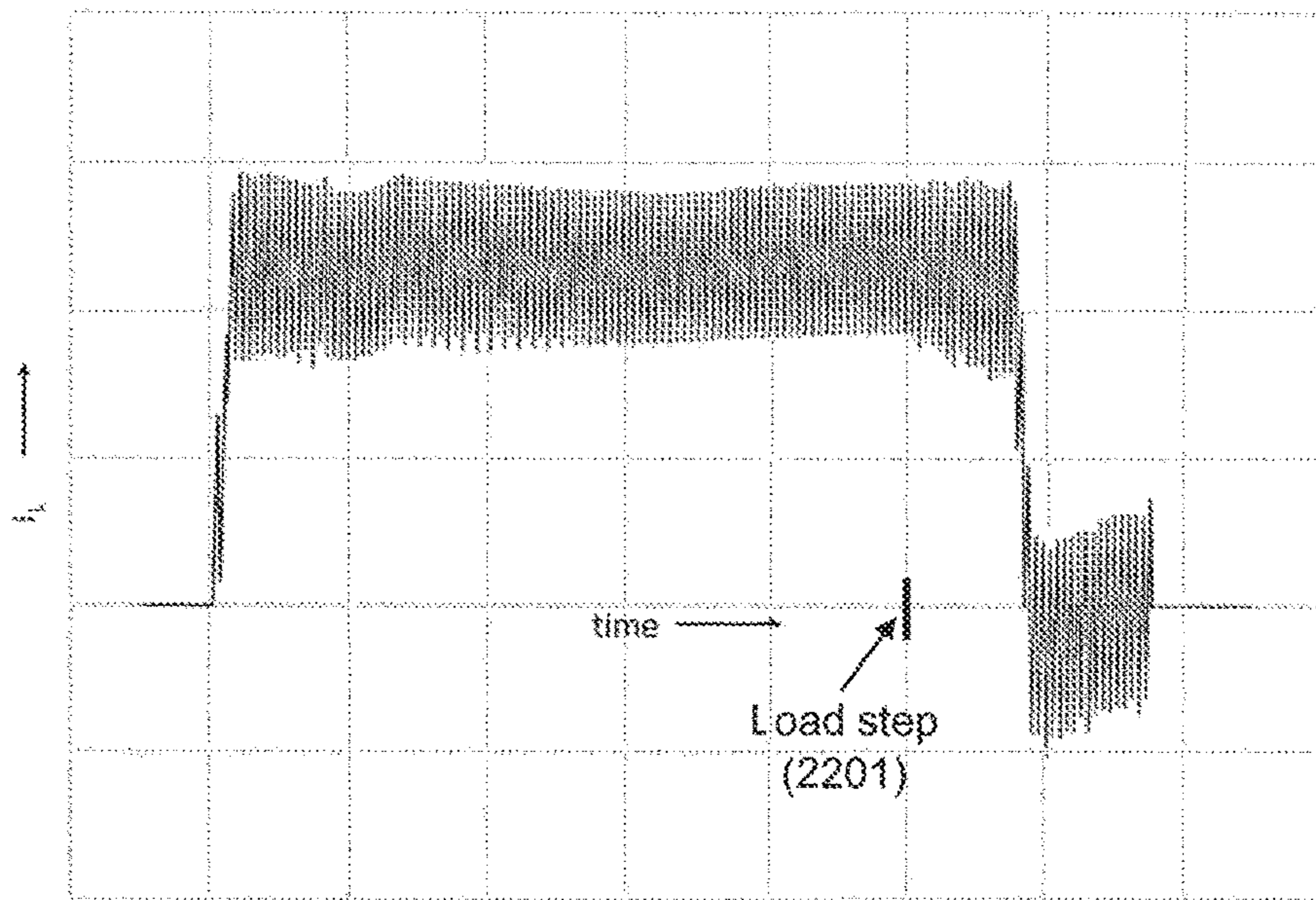


Figure 23

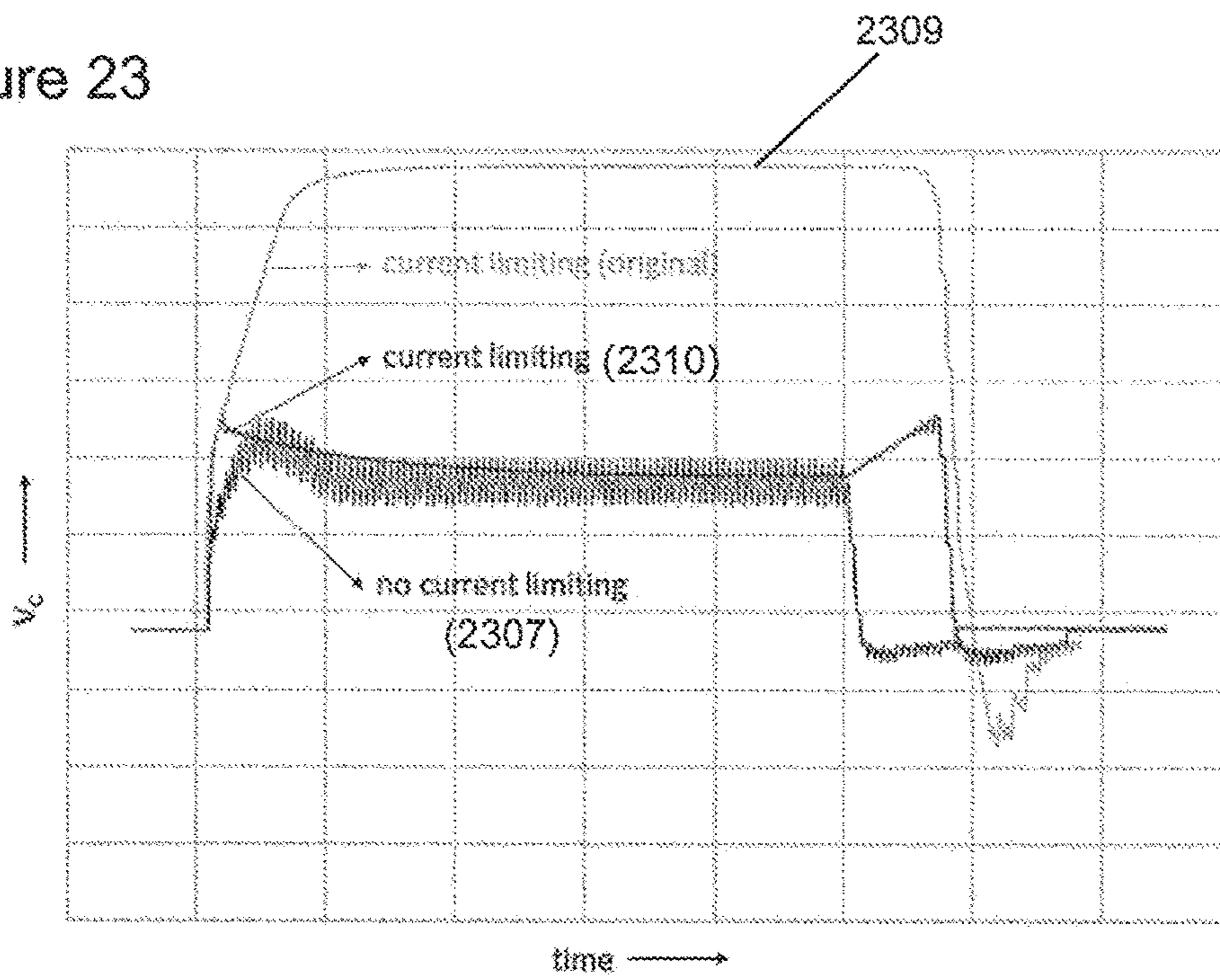


Figure 24

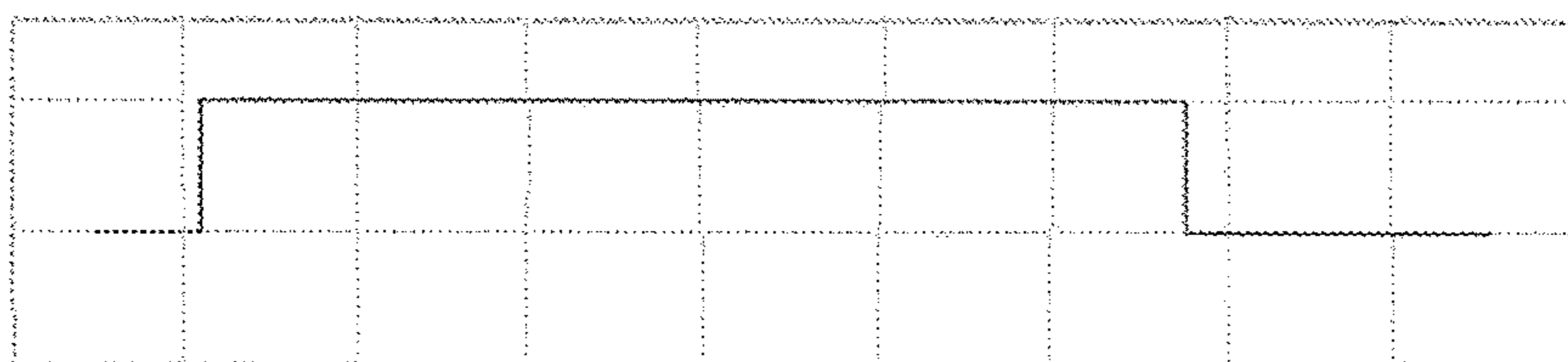


Figure 25

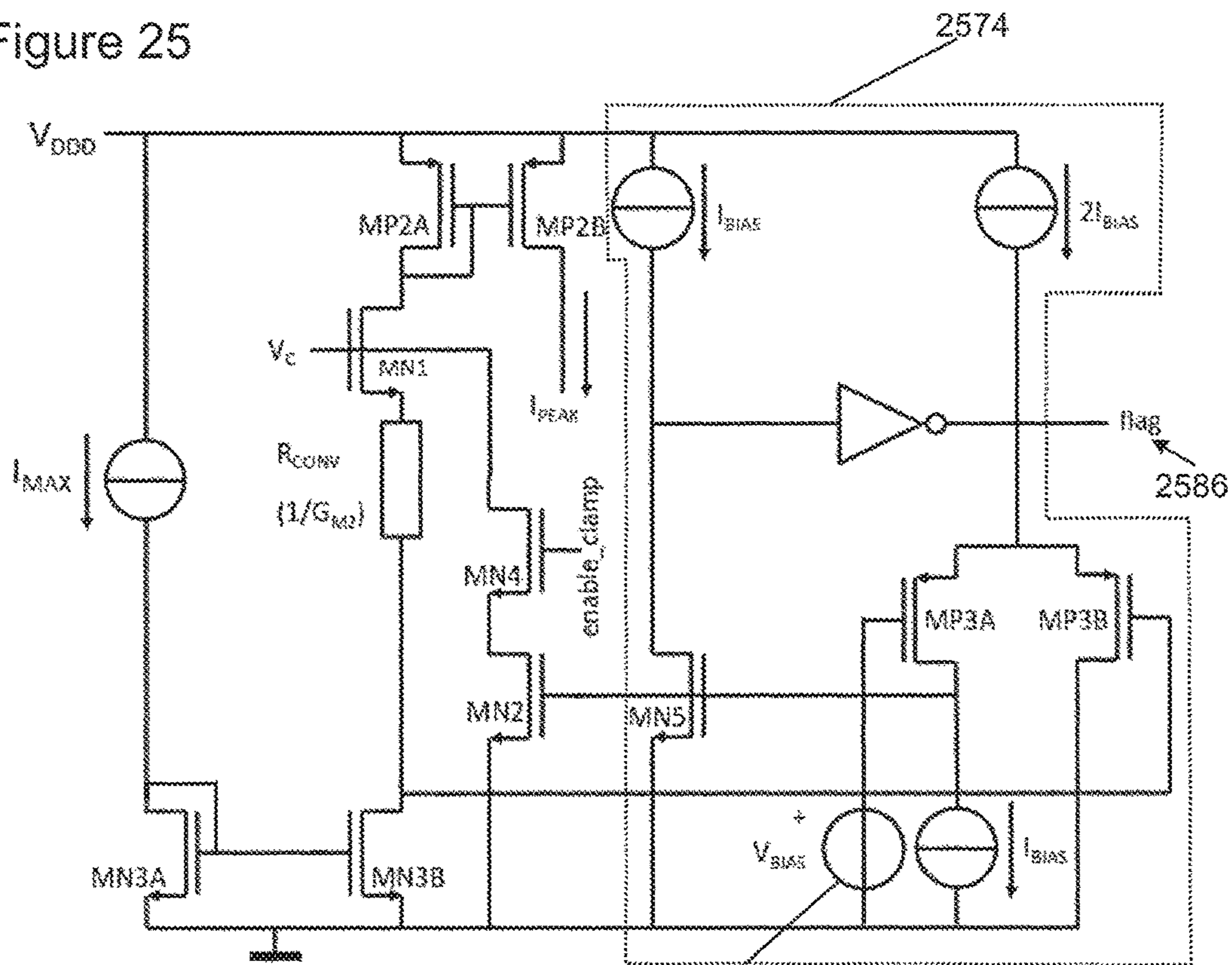
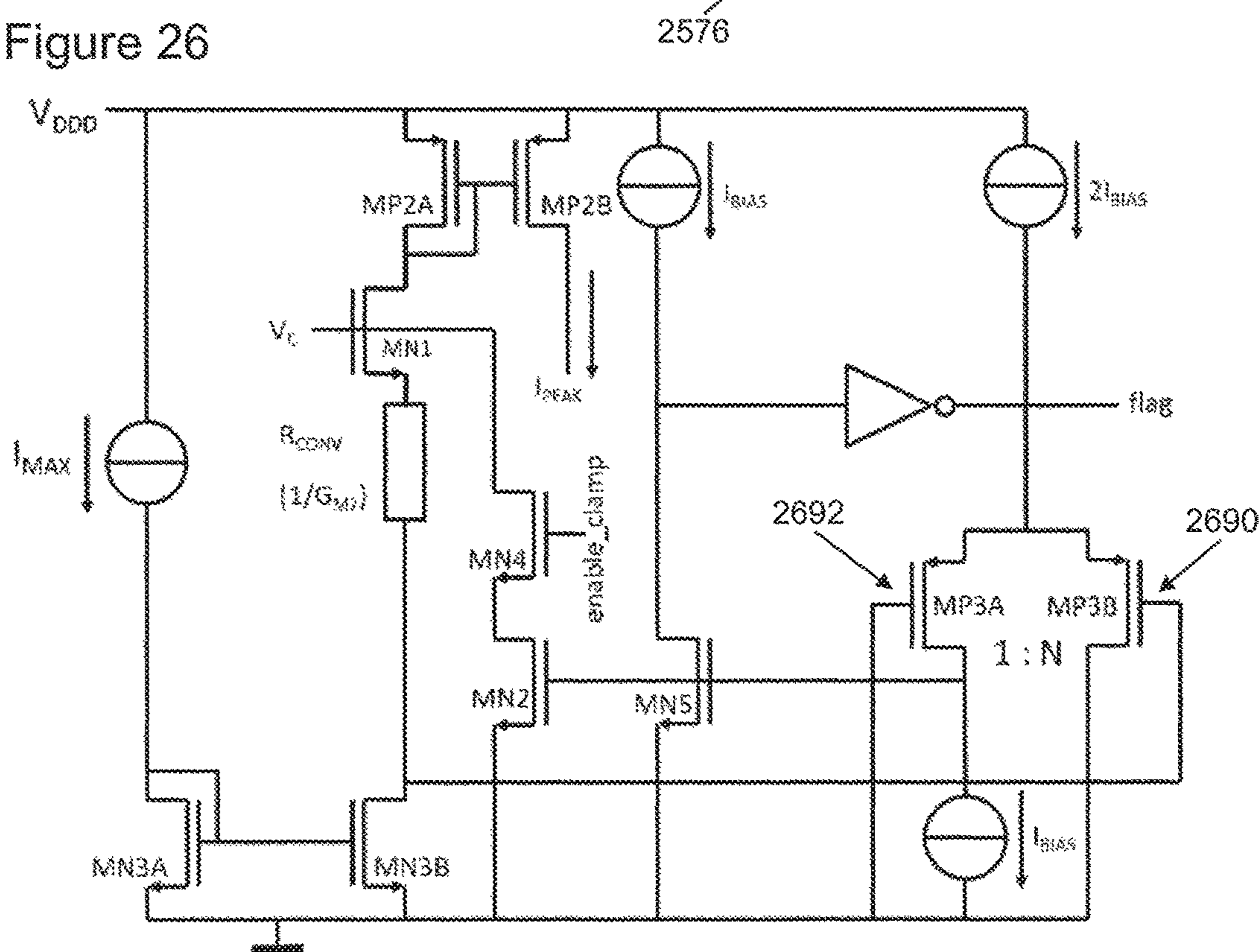
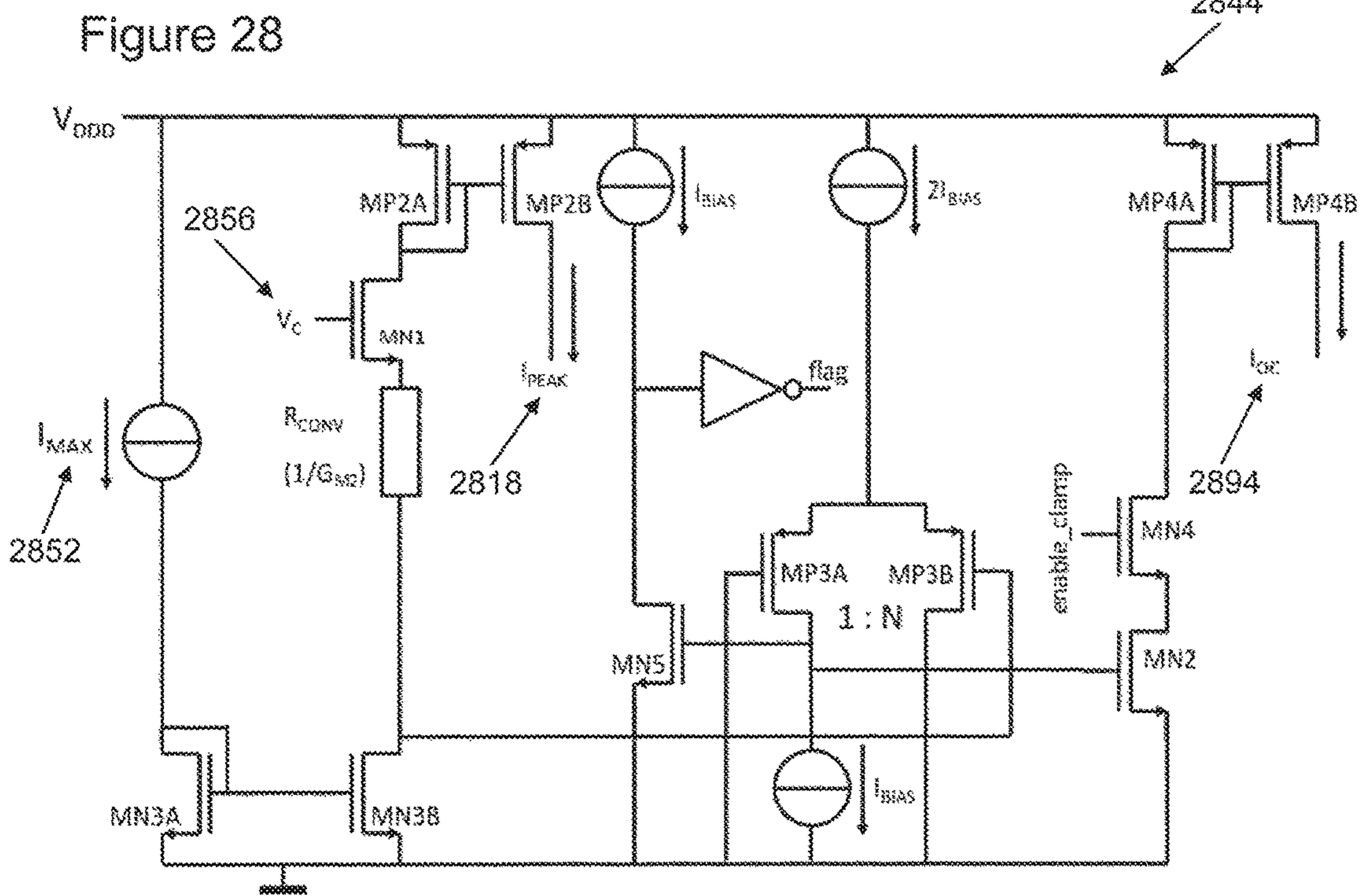
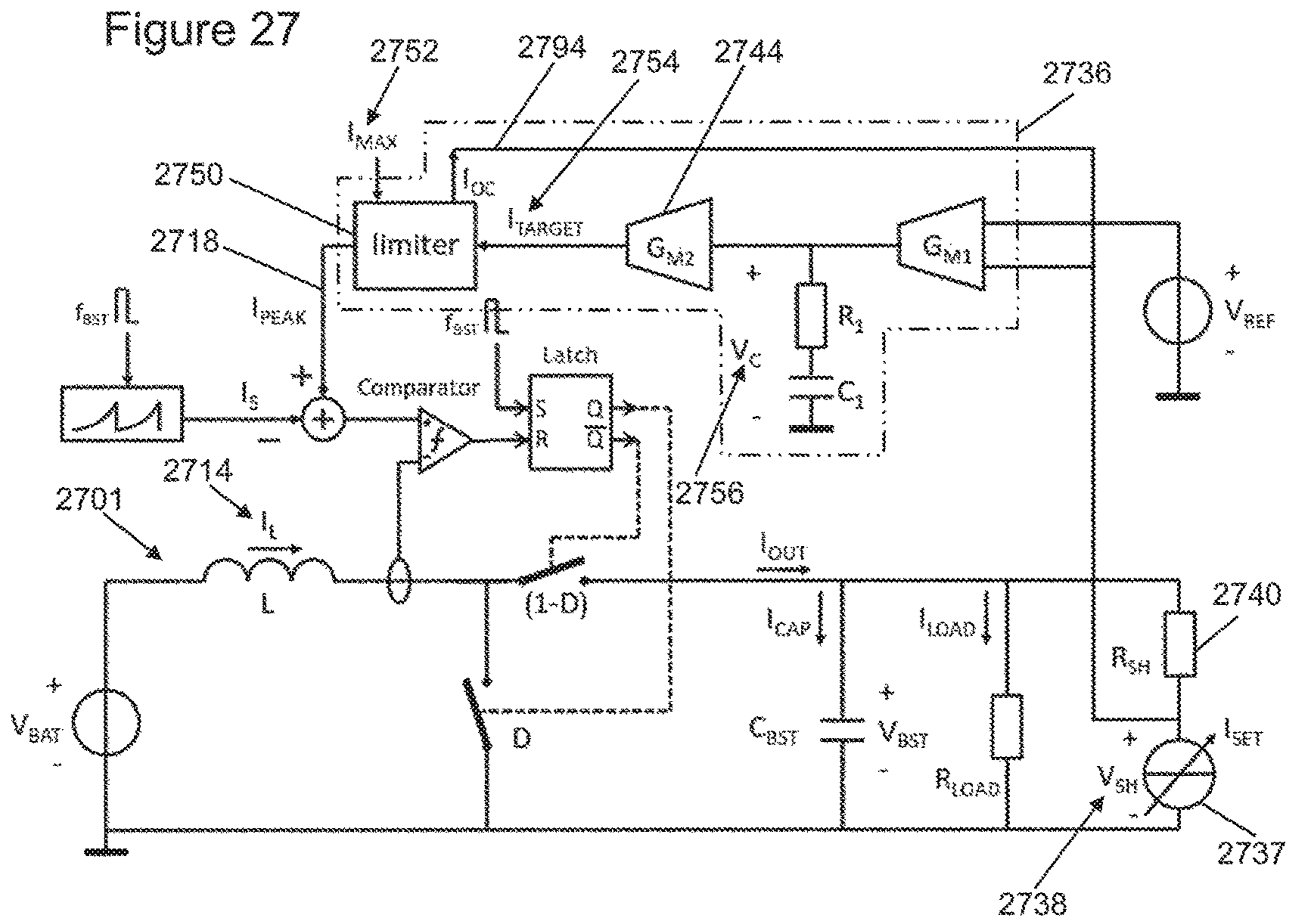


Figure 26





CIRCUIT FOR A SWITCHED MODE POWER SUPPLY

CROSS-REFERENCE TO RELATED APPLICATIONS

This application claims the priority under 35 U.S.C. § 119 of European patent application no. 17199564.0, filed Nov. 1, 2017 the contents of which are incorporated by reference herein.

The present disclosure relates to circuits for switched-mode-power-supplies, and in particular to circuits that have a controller, a current-limiter and a clamp-circuit.

According to a first aspect of the present disclosure there is provided a circuit for a switched-mode-power-supply, wherein the switched-mode-power-supply is configured to: receive a current-control-signal; and provide an output-voltage based on the current-control-signal, the circuit comprising:

a controller, configured to:

generate a control-voltage based on the difference between: (i) a sense-voltage, which is representative of the output-voltage of the switched-mode-power-supply; and (ii) a reference-voltage;

generate a target-current-control-signal based on the control-voltage, wherein the target-current-control-signal is configured to adjust the current through the switched-mode-power-supply in order to bring the sense-voltage closer to the reference-voltage;

a current-limiter configured to provide the current-control-signal as the target-current-control-signal limited to a max-current-control-value; and

a clamp-circuit configured to set the control-voltage to a clamp-voltage-value when the current-limiter provides the current-control-signal having the limited value of the max-current-control-value.

The clamp-circuit can advantageously prevent or reduce drift of the control-voltage when current limiting is used. In this way the control-voltage may not leave a normal operating region, and normal operation can be resumed more quickly when a load subsequently reduces to a lower level that does not require current limiting. This can beneficially reduce the overshoot on the output-voltage to a level that would occur without current limiting.

In one or more embodiments, the clamp-circuit comprises a voltage regulator. The voltage regulator may be configured to regulate the control-voltage to the clamp-voltage-value for all values of the sense-voltage and the reference-voltage that would cause the target-current-control-signal to be set to a value that is equal to or greater than the max-current-control-value.

In one or more embodiments, the controller comprises a transconductance-amplifier-control-block, which may incorporate the functionality of the current-limiter and the clamp-circuit. The transconductance-amplifier-control-block may be configured to: receive the control-voltage; prevent the control-voltage from increasing when the current-control-signal has the limited value of the max-current-control-value; and convert the control-voltage to the current-control-signal.

In one or more embodiments, the transconductance-amplifier-control-block comprises one or more of: a voltage amplifier, a bias-voltage-source configured to provide a saturation-voltage; a clamp-transistor; and a first-mirror-second-transistor. The voltage amplifier in combination with the clamp-transistor may be configured to regulate the

voltage drop across the first-mirror-second-transistor to the saturation-voltage provided by the bias-voltage-source.

In one or more embodiments, the transconductance-amplifier-control-block comprises a transistor, and optionally the transconductance-amplifier-control-block is configured to prevent the control-voltage from increasing when the voltage drop across the transistor exceeds a saturation-voltage of the transistor.

In one or more embodiments, the saturation-voltage is representative of the transistor being in a saturated state of operation.

In one or more embodiments, the transconductance-amplifier-control-block is configured prevent the control-voltage from increasing when a transistor in the transconductance-amplifier-control-block is in saturation.

In one or more embodiments, the controller comprises: a transconductance-amplifier-control-block, which may incorporate the functionality of the current-limiter and the clamp-circuit. The transconductance-amplifier-control-block may be configured to: receive the control-voltage; provide a non-zero over-current-signal when the current-control-signal has the limited value of max-current-control-value, wherein the over-current-signal may be configured to change the sense-voltage independently of the current through the switched-mode-power-supply; and convert the control-voltage to the current-control-signal.

In one or more embodiments, the switched-mode-power-supply includes a target-output-voltage, which may define a set-point for the switched-mode-power-supply, and the over-current-signal is configured to change the target-output-voltage to a level such that the current through the switched-mode-power-supply corresponds to the max-current-control-value.

In one or more embodiments, the clamp-voltage-value is a value of the control-voltage before the current-limiter provides the current-control-signal with the limited value of the max-current-control-value.

In one or more embodiments, the clamp-circuit is configured to clamp the control-voltage to its current value when the current-limiter provides the current-control-signal with the limited value of the max-current-control-value.

In one or more embodiments, the controller is configured to generate the control-voltage by integrating the difference between: (i) the sense-voltage; and (ii) the reference-voltage.

In one or more embodiments, the target-current-control-signal is configured to adjust the current through the switched-mode-power-supply by setting the peak current through an inductor in the switched-mode-power-supply.

In one or more embodiments, the clamp-circuit is configured to provide a flag-signal that is representative of whether or not the control-voltage is set to the clamp-voltage-value. The circuit may comprise a controllable-block that is configured to be automatically contrasted based on the flag-signal.

In one or more embodiments, the switched-mode-power-supply comprises a buck converter, a buck-boost converter or a flyback converter.

There may be provided an audio amplifier circuit comprising:

any circuit disclosed herein, wherein the clamp-circuit is configured to provide a flag-signal that is representative of whether or not the control-voltage is set to the clamp-voltage-value; and a controllable-block that is configured to be automatically controlled based on the flag-signal.

In one or more embodiments, the controllable-block comprises an amplifier. The amplifier may be configured to automatically control an audio level of an output signal of the audio amplifier circuit based on the flag-signal.

While the disclosure is amenable to various modifications and alternative forms, specifics thereof have been shown by way of example in the drawings and will be described in detail.

It should be understood, however, that other embodiments, beyond the particular embodiments described, are possible as well. All modifications, equivalents, and alternative embodiments falling within the spirit and scope of the appended claims are covered as well.

The above discussion is not intended to represent every example embodiment or every implementation within the scope of the current or future Claim sets. The figures and Detailed Description that follow also exemplify various example embodiments. Various example embodiments may be more completely understood in consideration of the following Detailed Description in connection with the accompanying Drawings.

BRIEF DESCRIPTION OF DRAWINGS

One or more embodiments will now be described by way of example only with reference to the accompanying drawings in which:

FIG. 1 shows an example circuit diagram of a boost converter;

FIG. 2 shows a boost converter with peak current mode control;

FIG. 3 shows a plot of current versus time for the inductor current I_L of the circuit shown in FIG. 2;

FIG. 4 shows the same waveforms as FIG. 3, and also an inductor-current-with-error $I_{L,ERR}$ signal;

FIG. 5 shows the same current waveforms in peak current mode control as those of FIG. 4, but this time for error propagation with $|S_2| > |S_1|$;

FIG. 6 shows a boost converter with peak current mode control and slope compensation;

FIG. 7 shows the same current waveforms in peak current mode control as those of FIGS. 4 and 5, and also $(I_{PEAK} - I_S)$;

FIG. 8 shows a boost converter with peak current mode control and parabolic slope compensation;

FIG. 9 shows various current waveforms for the circuit of FIG. 8;

FIG. 10 shows a boost converter with peak current mode control and parabolic slope compensation, with a more detailed view of the switches and the current measurement;

FIG. 11 shows a boost converter with peak current mode control, parabolic slope compensation and a P-I controller for providing an output-voltage control loop;

FIG. 12 shows a boost converter, which is similar to the boost converter of FIG. 11, with peak current mode control and parabolic slope compensation, with further details of an implementation of the P-I controller;

FIG. 13 shows a boost converter, which is similar to the boost converter of FIG. 12, with peak current mode control, parabolic slope compensation, an output voltage control loop and also a current-limiter;

FIG. 14 shows an example implementation of a second transconductance amplifier-control-block, which provides the functionality of both the second transconductance-amplifier-control-block and the current-limiter of FIG. 13;

FIG. 15 shows a plot of inductor current I_L versus time for a step-up and step-down in the load current, for the circuit of FIG. 13;

FIG. 16 shows another plot of inductor current I_L versus time for a step-up and step-down in the load current;

FIG. 17 shows two plots of output-voltage V_{BST} versus time;

FIG. 18 shows two plots of the control-voltage V_C versus time;

FIG. 19 shows an example embodiment of a circuit that includes a switched-mode-power-supply;

FIG. 20 shows an example embodiment of a transconductance-amplifier-control-block that provides the functionality of the second sub-processing block, the current-limiter, and the clamp-circuit of FIG. 19;

FIG. 21 shows three plots of output-voltage V_{BST} versus time, including a plot for the circuit of FIG. 19/20;

FIG. 22 shows the inductor current I_L during a load step-up and step-down, including a plot for the circuit of FIG. 19/20;

FIG. 23 shows three plots of the control-voltage V_C versus time, including a plot for the circuit of FIG. 19/20;

FIG. 24 shows a plot of the flag-signal of FIG. 20.

FIG. 25 shows an example embodiment of the transconductance-amplifier-control-block of FIG. 20, which provides the functionality of the second sub-processing block, the current-limiter, and the clamp-circuit of FIG. 10;

FIG. 26 shows an example embodiment of a transconductance-amplifier-control-block, which is similar to that of FIG. 25;

FIG. 27 shows another example embodiment of a circuit that includes a SMPS and a controller; and

FIG. 28 shows an example implementation of the second sub-processing block of FIG. 27.

In modern battery operated portable electronic equipment, such as smart phones, high efficiency boost converters are used for circuits that require a voltage above the battery voltage. In a boost converter, a controller is used to regulate the boost voltage to the required level. The amount of overshoot or undershoot on this boost voltage after a load step is an important performance indicator for the speed and quality of the controller. If the load or the converter itself has a maximum voltage, any overshoot can decrease the margin between maximum and nominal boost voltage.

In a boost converter, a limitation on the coil/inductor current can be implemented to prevent inductor saturation, excessive battery currents, or damage in the circuit itself. When current limitation is active, for example for heavy loads, the target boost voltage can no longer be reached and the controller is no longer able to control the boost voltage. There can be a large error voltage on the input of the controller in this situation. Controllers can have an integrating function for high boost voltage accuracy, in which case the integrated error voltage will drift away when current limiting is occurring. When the heavy load is no longer present, the current will stay at the maximum level until the boost voltage is back at the target level. Then the recovery starts, the error voltage changes sign and the integrated error voltage will decrease back to normal operating level. The amount of drift will determine how much time this recovery takes. This can lead to a much higher boost voltage overshoot than in the case of a load step under non-limited current levels. The longer the recovery takes, the higher the overshoot on the boost voltage will be.

FIG. 1 shows an example circuit diagram of a boost converter 100, which provides an output-voltage V_{BST} . The boost converter includes an inductor 102 that is connected between a battery 104 and two switches: Switch 1 106 and Switch 2 108. The two switches 106, 108 connect the inductor 102 either to ground 110 or to an output capacitor

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C_{BST} **112**. Switch 1 **106** is closed with switching frequency f_{BST} (or period T) and duty cycle D . Switch 2 **108** is closed when Switch 1 **106** is open. The resulting current I_L in the inductor **102** is a triangular shaped current with slopes determined by the battery voltage V_{BAT} and the difference between battery and output-voltage $V_{BAT}-V_{BST}$. In the configuration of FIG. 1, the ratio between output-voltage and battery voltage is determined by the duty cycle D used to operate the switches ($D'=1-D$):

$$V_{BST} = \frac{V_{BAT}}{1-D} = \frac{V_{BAT}}{D'} \quad (1)$$

FIG. 2 shows a boost converter **200** with peak current mode control. In the current mode controlled boost converter **200** of FIG. 2, the duty cycle control of the switches **206**, **208** is performed with peak current mode control. In peak current mode control, the inductor current I_L **214** is compared to a peak-current-control-signal I_{PEAK} **218** by a comparator **214**. At the beginning of each cycle, at the rising edge of f_{BST} , switch 1 **206** is closed and I_L **214** increases with slope $S_1 (>0)$. As soon as I_L **214** is equal to the peak-current-control-signal I_{PEAK} **218**, the comparator **214** resets a latch **216**, and switch 2 **208** is closed (and switch 1 **206** is opened). In response, the inductor current I_L **214** decreases with slope $S_2 (<0)$.

FIG. 3 shows a plot of current (on the vertical axis) versus time (on the horizontal axis) for the inductor current I_L **314** of the circuit shown in FIG. 2. As discussed above, FIG. 2 shows a boost converter operating in peak current control. Also shown in FIG. 3 is the peak-current-control-signal I_{PEAK} **318**. Furthermore, the switching periods (T) are marked on the horizontal axis, and a single period is marked up with reference to the duty cycle D that is being used.

In steady state, the operation shown in FIG. 3 defines the relation:

$$S_1DT + S_2(1-D)T = 0 \quad (2)$$

With this method, the peak value of the triangular inductor current I_L **314** is regulated to the peak-current-control-signal I_{PEAK} **318**. Switch 1 is closed at the rising edge of a clock signal f_{BST} and opened as soon as the measured current through the coil I_L **314** is equal to the peak-current-control-signal I_{PEAK} **318**. In FIG. 3, the average inductor current $I_{L,AVG}$ **319** is also shown.

FIG. 4 shows the same waveforms as FIG. 3, and also an inductor-current-with-error $I_{L,ERR}$ **420** signal. FIG. 4 shows the current waveforms in peak current mode control, including error propagation but without slope compensation (which will be described below with reference to FIGS. 6 to 9).

$I_{L,ERR}$ **420** is the actual current in the inductor following a change in the load current (for example at time=0). I_L **414** is the appropriate steady state inductor current for the new load current. As shown in FIG. 4, the system takes a few cycles to adjust to the new load, following which $I_{L,ERR}$ **420** is a good match for I_L **414**. $I_{L,AVG}$ **419** represents the average current through the inductor.

In FIG. 4 the propagation of an error $\Delta I_{L,0}$ **422** in the current through the inductor at $t=0$ can be seen. The duty cycle D of the period with $0 < t < T$ is altered due to the error in the current $\Delta I_{L,0}$ **422** with:

$$\Delta D = -\frac{\Delta I_{L,0}}{S_1} \quad (3)$$

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The current error $\Delta I_{L,1}$ at $t=T$ will then be equal to:

$$\Delta I_{L,1} = -\Delta D S_2 = \frac{\Delta I_{L,0} S_2}{S_1} \quad (4)$$

The amplification of the current error after one cycle is therefore equal to

$$\frac{\Delta I_{L,1}}{\Delta I_{L,0}} = \frac{S_2}{S_1} = \frac{-D}{1-D} \quad (5)$$

After n cycles, the original error has amplified with a factor $A(n)$:

$$\Delta I_{L,n} = \Delta I_{L,0} A(n) = \Delta I_{L,0} \left(\frac{S_2}{S_1} \right)^n \quad (6)$$

Since $S_2 > 0$ and $S_1 > 0$, the error has an alternating sign. Note that this system is not stable when $|S_2| > |S_1|$, so for $D > 50\%$. However, in FIG. 4, $|S_2| < |S_1|$, and therefore the magnitude of the error ΔI_L reduces over time.

FIG. 5 shows the same current waveforms in peak current mode control as those of FIG. 4, with corresponding reference numbers in the 500 series, but this time for error propagation with $|S_2| > |S_1|$. FIG. 5 shows unstable behaviour, where the error increases (is amplified) over time, which leads to undesired sub-harmonic oscillations.

FIG. 6 shows a boost converter **600** with peak current mode control and slope compensation.

Slope compensation can be used to control the damping and ensure stable behavior for duty cycles above 50%. With slope compensation, a periodic current I_S **624** with slope S_3 is subtracted from the peak-current-control-signal I_{PEAK} **618** as shown in FIG. 6. The result of the subtraction is $(I_{PEAK} - I_S)$ **625**. In this example, linear slope compensation is used; that is, S_3 has a constant value.

FIG. 7 shows the same current waveforms in peak current mode control as those of FIGS. 4 and 5, with corresponding reference numbers in the 700 series. FIG. 7 also shows $(I_{PEAK} - I_S)$ **725**, which is identified in FIG. 6. FIG. 7 shows current mode control with slope compensation and $|S_2| > |S_1|$, having stable behavior.

For the circuit of FIG. 6 and waveforms of FIG. 7, the duty cycle D of the first period $0 < t < T$ will then be altered with

$$\Delta D = \frac{\Delta I_{L,0}}{S_1 - S_3} \quad (7)$$

The current error at $t=T$ will now be equal to:

$$\Delta I_{L,1} = -\Delta D (S_2 - S_3) = \frac{\Delta I_{L,0} (S_2 - S_3)}{S_1 - S_3} \quad (8)$$

The amplification of the error is therefore equal to

$$\frac{\Delta I_{L,1}}{\Delta I_{L,0}} = \frac{S_2 - S_3}{S_1 - S_3} \quad (9)$$

After n cycles, the original error $I_{L,0}$ has amplified with a factor $A(n)$:

$$\Delta I_{L,n} = \Delta I_{L,0} A(n) = \Delta I_{L,0} \left(\frac{S_2 - S_3}{S_1 - S_3} \right)^n \quad (10)$$

To guarantee stability, S_3 should be chosen in such a way that the magnitude of the term between the brackets is below 1. Otherwise, the error explodes and sub harmonic oscillations can occur.

$$|A| < 1 \text{ or } \left| \frac{S_2 - S_3}{S_1 - S_3} \right| < 1 \quad (11)$$

Consider that only S_1 is positive, and S_2 and S_3 are negative. The term between the brackets can be both negative and positive, dependent on S_3 .

$S_2 < S_3 < 0$ $-1 < A < 0$ the under damped case, the error is alternating in sign.

$S_3 < S_2 < 0$ $0 < A < 1$ the over damped case, the error keeps the same sign.

$S_3 < S_2 < 0$ $A=0$ the critically damped case, the error is corrected in a single period.

The situation with $S_3=S_2$, or $A=0$, gives the fastest possible transient response. This can be the optimum slope control.

FIG. 8 shows a boost converter 800 with peak current mode control and parabolic slope compensation. In this example, a periodic current I_S 824 with a parabolic slope is used.

FIG. 9 shows the following current waveforms for the circuit of FIG. 8:

inductor-current I_L 914;

peak-current-control-signal I_{PEAK} 918;

$(I_{PEAK} - I_S)$; and

average inductor current $I_{L,AVG}$ 919.

In the boost converter, the current slopes S_1 and S_2 depend on the duty cycle D .

$$S_1(D) = \frac{V_{BAT}}{L} = (1-D) \frac{V_{BST}}{L} = D' \frac{V_{BST}}{L} \quad (12)$$

$$S_2(D) = \frac{V_{BAT} - V_{BST}}{L} = \frac{(1-D)V_{BST} - V_{BST}}{L} = -D \frac{V_{BST}}{L} \quad (13)$$

When a constant value is chosen for S_3 (as in FIGS. 6 and 7), there is only one operating condition where the damping is critical ($A=0$). Even when $|A| < 1$ for all operating conditions and stability is guaranteed, this means that the error correction can take many periods thereby resulting in a slow response. When optimal slope control with critical damping is required (with $S_3=S_2$) for all values of D , then the value of S_3 should also depend on the duty cycle D :

$$S_3(D) = -D \frac{V_{BST}}{L} \quad (14)$$

So, at $t=DT$, the slope current derivative should be equal to S_3 . Or, in the time domain:

$$S_3(t) = -\frac{\epsilon V_{BST}}{TL} \quad (15)$$

If the derivative of the slope current S_3 depends linearly on the relative time in the period, the current itself depends on the square of the relative time, starting at 0 for $t/T=0$:

$$I_S(t) = \int_{x=0}^{x=t} -S_3(x) dx = \quad (16)$$

$$\frac{V_{BST}}{TL} \int_{x=0}^{x=t} x dx = \frac{V_{BST} t^2}{2TL} = \frac{V_{BST} T}{2L} \left(\frac{t}{T} \right)^2 = \frac{V_{BST}}{2fL} \left(\frac{t}{T} \right)^2$$

FIG. 10 shows a boost converter 1000 with peak current mode control and parabolic slope compensation, which is similar to the circuit of FIG. 8 but with a more detailed view of the switches and the current measurement. Components that are shown in earlier figures have been given corresponding reference numbers in the 1000 series, and will not necessarily be described again here.

The power switches 1006, 1008 of the boost converter are implemented with power transistors: $M_{N,POWER}$ 1006, which corresponds to switch 1 in earlier figures; and $M_{P,POWER}$ 1008, which corresponds to switch 2 in earlier figures. These two power switches 1006, 1008 are driven by drivers that supplied by voltage sources V_{DN} 1026 and V_{DP} 1030 respectively.

The parabolic slope current I_S 1024 is extracted from the peak-current-control-signal I_{PEAK} 1018. The resulting current $(I_{PEAK} - I_S)$ 1025 is forced into a reference transistor M_{REF} 1030, which is a scaled replica of the power transistor $M_{N,POWER}$ 1006 with scaling factor K . At the positive edge of f_{BST} , $M_{N,POWER}$ 1006 is switched on by pulling its gate voltage towards V_{DN} 1026 which is the supply voltage for the driver stage. The gate of the reference transistor M_{REF} 1032 is also at V_{DN} . Sense transistors $M_{N,SENSE1}$ 1032 and $M_{N,SENSE2}$ 1034 divide the voltage across the power transistor $M_{N,POWER}$ 1006 by a factor two when $M_{N,POWER}$ 1006 is on, and pull the positive input of the comparator 1014 to ground when $M_{N,POWER}$ 1006 is off.

The output of the comparator 1014 will now change when:

$$I_L = 2K(I_{PEAK} - I_S) \quad (17)$$

When the output of the comparator 1014 changes: the latch 1016 is reset: $M_{N,POWER}$ 1006 is switched off; and $M_{P,POWER}$ 1008 is switched on until the next positive edge of f_{BST} .

FIG. 11 shows a boost converter 1100 with peak current mode control, parabolic slope compensation, and a P-I controller 1136 for providing an output-voltage control loop.

The set point for the output-voltage V_{BST} in FIG. 11 is created by a programmable current source 1137, which provides a current I_{SET} . The programmable current source 1137 can use I_{SET} to set the voltage across a sense resistor R_{SH} 1140. This voltage across R_{SH} 1140, can be referred to as a sense-voltage V_{SH} 1138, and is equal to:

$$V_{SH} = V_{BST} - R_{SH} I_{SET} \quad (18)$$

The P-I controller 1136 compares this sense-voltage V_{SH} 1138 to a reference voltage V_{REF} 1142, which is provided by a reference-voltage-source in FIG. 11. The difference between V_{REF} 1142 and V_{SH} 1138 can be referred to as the error voltage. The P-I controller 1136 then translates the error voltage to the peak-current-control-signal I_{PEAK} 1118.

The P-I controller **1138** adjusts the peak-current-control-signal I_{PEAK} **1118** (based on the error voltage) to set the output-voltage V_{BST} of the boost converter. More particularly, the P-I controller **1136** can adjust the current through the boost converter and bring the sense-voltage V_{SH} closer to the reference-voltage V_{REF} . In this example, the peak-current-control-signal I_{PEAK} **1118** is used to control the duty cycle for the switching cycle of the boost converter, thereby controlling the output-voltage V_{BST} .

FIG. **12** shows a boost converter **1200**, which is similar to the boost converter of FIG. **11**, with peak current mode control and parabolic slope compensation. FIG. **12** shows further details of an implementation of the P-I controller **1236**, which provides the output voltage control loop.

If the boost voltage is an target, then $V_{REF}=V_{SH}$ and

$$V_{BST}=V_{REF}+R_{SH}I_{SET} \quad (19)$$

The P-I controller **1236** includes a first transconductance-amplifier-control-block G_{M1} **1243** and a second transconductance-amplifier-control-block G_{M2} **1244**. The first transconductance-amplifier-control-block G_{M1} **1243** receives the sense-voltage V_{SH} **1238** and the reference voltage V_{REF} **1242**, and provides an output signal that has a current that is based on the difference between V_{SH} **1238** and V_{REF} **1242**. A control-resistor R_1 **1246** and a control-capacitor C_1 are connected in series between the output terminal of the first transconductance-amplifier-control-block G_{M1} **1243** and ground. In this way, the current that is provided as the output signal of the first transconductance-amplifier-control-block G_{M1} **1243** causes a control-voltage V_C **1256** to be dropped across the control-resistor R_1 **1246** and the control-capacitor C_1 .

The P-I controller **1236** can generate the control-voltage V_C **1256** by integrating the difference between: (i) the sense-voltage V_{SH} **1238**; and (ii) the reference-voltage V_{REF} **1242**. In this way, the control-voltage V_C **1256** can be considered as the integrated error voltage in some examples.

The second transconductance-amplifier-control-block G_{M2} **1244** converts the control-voltage V_C **1256** to the peak-current-control-signal I_{PEAK} **1218**. An input terminal of the second transconductance-amplifier-control-block G_{M2} **1244**, which receives the control-voltage V_C **1256**, can be referred to as a control-voltage-input-terminal.

FIG. **13** shows a boost converter **1300**, which is similar to the boost converter of FIG. **12**, with peak current mode control, parabolic slope compensation, and an output voltage control loop. FIG. **13** also includes a current-limiter **1350**.

In this example, the output signal from the second transconductance-amplifier-control-block G_{M2} **1344** is labelled as I_{TARGET} **1354** and may be referred to as a target-current-control-signal. In the same way as discussed above, the target-current-control-signal I_{TARGET} **1354** is configured to adjust the current through the boost converter in order to bring the sense-voltage V_{SH} closer to the reference-voltage V_{REF} ; optionally by setting the peak current through the inductor in the boost converter **1300**.

The current-limiter **1350** can limit the peak-current-control-signal I_{PEAK} **1318**. The current-limiter is connected to the output terminal of the second transconductance-amplifier-control-block G_{M2} **1344**, such that it receives the target-current-control-signal I_{TARGET} **1354**. The current-limiter **1350** provides the peak-current-control-signal I_{PEAK} as the target-current-control-signal I_{TARGET} **1354** limited to a max-current-control-value I_{MAX} **1352**. That is:

- (i) the peak-current-control-signal I_{PEAK} **1318** equals the target-current-control-signal I_{TARGET} **1354**, when the

target-current-control-signal I_{TARGET} **1354** is less than or equal to the max-current-control-value I_{MAX} **1352**; and

- (ii) the peak-current-control-signal I_{PEAK} **1318** equals the max-current-control-value I_{MAX} **1352**, when the target-current-control-signal I_{TARGET} **1354** is greater than the max-current-control-value I_{MAX} **1352**.

The max-current-control-value I_{MAX} **1352** can be considered as defining a programmable maximum average current level. The maximum peak current level can depend on the maximum average current $I_{L,AVG,MAX}$, battery voltage V_{BAT} , boost voltage V_{BST} , inductor value L and switching frequency f :

$$I_{PEAK,MAX} = I_{L,AVG,MAX} + \frac{V_{BST} - V_{BAT}}{2fL} \quad (20)$$

FIG. **14** shows an example implementation of a second transconductance-amplifier-control-block **1444**, which provides the functionality of both the second transconductance-amplifier-control-block G_{M2} and the current-limiter of FIG. **13**.

The second transconductance-amplifier-control-block **1444** receives the control-voltage V_C **1456** as an input signal, and provides the peak-current-control-signal I_{PEAK} **1418** as an output signal. In line with the above discussion, the second transconductance-amplifier-control-block **1444** converts the control-voltage V_C **1456** into a current signal, and then limits/caps that current signal at a maximum value in order to provide the peak-current-control-signal I_{PEAK} **1418**.

The second transconductance-amplifier-control-block **1444** includes a max-current-source **1458**, which provides a current signal at the max-current-control-value I_{MAX} **1452**. The second transconductance-amplifier-control-block **1444** also includes a first current mirror **1461**, which includes a first-mirror-first-transistor MN3A **1460** and a first-mirror-second-transistor MN3B **1464**. The conduction channel of the first-mirror-first-transistor MN3A **1460** is connected in series with the max-current-source **1458**.

The second transconductance-amplifier-control-block **1444** also includes an input-transistor MN1A **1468**, which receives the control-voltage V_C **1456** at its control terminal. The conduction channel of the input-transistor MN1A **1468** is connected in series with: (i) a conversion-resistor R_{CONV} **1466**; and (ii) the conduction channel of the first-mirror-second-transistor MN3B **1464**. The value of the conversion-resistor R_{CONV} **1466** defines the value of transconductance of the second transconductance-amplifier-control-block **1444**: $G_{M2}=1/R_{CONV}$.

FIG. **14** also shows a second current mirror **1482**, which includes a second-mirror-first-transistor MN2A **1470** and a second-mirror-second-transistor MN2B **1472**. The conduction channel of the second-mirror-first-transistor MN2A **1470** is also connected in series with the conduction channel of the input-transistor MN1A **1468**. The conduction channel of the second-mirror-second-transistor MN2B **1472** provides the peak-current-control-signal I_{PEAK} **1418**.

(In this example the transistors are FETs, and therefore their control terminals are gate terminals, and their conduction channels extend between a drain terminal and a source terminal. In other examples, BJTs can be used instead of FETS.)

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For low levels of the control-voltage V_C **1456**, the first-mirror-second-transistor MN3B **1464** is in its linear region, and therefore the peak-current-control-signal I_{PEAK} **1418** will be equal to

$$I_{PEAK} = \frac{V_C - V_{T,MN1}}{R_{CONV} + R_{MNsB}} \quad (21)$$

That is, changes to the control-voltage V_C **1456** when it has a “low value” (that is, one that does not saturate the first-mirror-second-transistor MN3B **1464**), cause a change in the current flowing through the second-mirror-first-transistor MN2A **1470**, which in turn causes a change in the I_{PEAK} current **1418** flowing through the second-mirror-second-transistor MN2B **1472**.

When the control-voltage V_C **1456** is sufficiently increased, the peak-current-control-signal I_{PEAK} **1418** will saturate to I_{MAX} **1452** because the first-mirror-second-transistor MN3B **1464** will go into the saturation region, and limit the current through the input-transistor MN1 **1468** to I_{MAX} **1452**. Any further voltage increase of the control-voltage V_C **1456** will be followed by a voltage increase on the drain of the first-mirror-second-transistor MN3B **1464** without changing the current through the first-mirror-second-transistor MN3B **1464**.

Therefore, when the load current is increased, a point will be reached where the current through the coil/inductor of the boost converter will be limited.

FIG. **15** shows a plot of inductor current I_L versus time for a step-up and step-down in the load current, for the circuit of FIG. **13**. The timing of the load step down is labelled in FIG. **15** with reference number **1501**. For the plot of FIG. **15**, the inductor current I_L does not exceed the max-current-control-value I_{MAX} , and therefore no current limiting occurs.

FIG. **16** shows another plot of inductor current I_L versus time for a step-up and step-down in the load current. Again, the timing of the load step down is labelled in FIG. **16** with reference number **1601**. The size of the load current step for FIG. **16** has double the amplitude of the load current step for FIG. **15**. For FIG. **16**, the maximum average inductor current is exceeded and therefore the inductor current I_L is limited to the max-current-control-value I_{MAX} .

FIG. **17** shows two plots of output-voltage V_{BST} versus time:

- a first plot **1703** that corresponds to the load step-up and step-down of FIG. **15**, that is a load step that does not result in current limiting; and
- a second plot **1705** that corresponds to the load step-up and step-down of FIG. **16**, that is a load step that does result in current limiting.

The second plot **1705** shows that the output-voltage V_{BST} can collapse when current limiting is used.

With reference to the PI-controller **1336** of FIG. **13**, when current limiting is active, the error voltage at the input of G_{M1} **1343** will grow since the control loop is no longer capable of regulating the output-voltage V_{BST} . The integrating character of the PI-controller **1336** can cause the control-voltage V_C to drift to the supply voltage of G_{M1} **1343**, and away from the normal operating region.

FIG. **18** shows two plots of the control-voltage V_C versus time:

- a first plot **1807** that corresponds to the load step-up and step-down of FIG. **15**, that is a load step that does not result in current limiting; and

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a second plot **1809** that corresponds to the load step-up and step-down of FIG. **16**, that is a load step that does result in current limiting.

As can be seen from the second plot **1809** in FIG. **18**, due to the integrating character of the PI-controller, the control-voltage V_C drifts away from the normal operating region. When the load current drops to normal levels again at load step **1801**, the current through the coil I_L will stay at the maximum level until the output-voltage V_{BST} is regulated back to the target level. Then recovery starts, the error voltage (difference between V_{SH} and V_{REF}) changes sign, and the control-voltage V_C will reduce until the normal operating region is reached again. Because of the drift of V_C during current limiting, this recovery can take a significant amount of time, which can be too long for some applications. During this recovery time, the coil current I_L can be too high, thereby causing an overshoot on the output-voltage V_{BST} that is significantly higher than for a load step without current limiting. This undesired overshoot can be seen in the second plot of FIG. **17**, after the load step.

One or more of the following circuits can advantageously prevent or reduce drift of the control-voltage V_C when current limiting is used. For example, the control-voltage V_C can be clamped to the voltage level at which current limiting starts. In this way, the control-voltage V_C may not leave the normal operating region. When the load subsequently reduces to a lower level that does not require current limiting, normal operation can be resumed more quickly, and in some examples immediately. This can beneficially reduce the overshoot on the output-voltage to a level that would occur without current limiting.

FIG. **19** shows an example embodiment of a circuit **1900** that includes a switched-mode-power-supply (SMPS) **1901**. The SMPS **1901** may be a boost converter, as discussed above. In other examples, the SMPS **1901** may be a buck converter, a buck-boost converter or a flyback converter, as non-limiting examples.

The SMPS **1901** receives a current-control-signal $I_{CONTROL}$ **1918**, and provides an output-voltage V_{OUT} based on the current-control-signal $I_{CONTROL}$ **1918**. In some examples the current-control-signal $I_{CONTROL}$ **1918** can be a peak-current-control-signal as discussed above.

The circuit **1900** includes a controller **1936**. In some examples, the controller **1936** can operate the SMPS **1901** in a fixed frequency mode of operation. The controller **1936** can generate a control-voltage V_C **1956** based on the difference between: (i) a sense-voltage V_{SH} **1938**; and (ii) a reference-voltage V_{REF} **1942**. The sense-voltage V_{SH} **1938** is representative of the output-voltage V_{OUT} of the SMPS **1901**, and can be implemented as shown in FIG. **11** for example. In this example, the control-voltage V_C **1956** is a signal that is internal to the controller **1936**.

The controller **1936** can also generate a target-current-control-signal I_{TARGET} **1954** based on the control-voltage V_C **1956**. The target-current-control-signal I_{TARGET} **1954** is configured to adjust the current through the SMPS **1901** in order to bring the sense-voltage V_{SH} **1938** closer to the reference-voltage V_{REF} **1942**. The controller **1936** can perform this functionality in the same way as described above, for example with reference to FIG. **11**.

The circuit **1900** also includes a current-limiter **1950**. The current-limiter **1950** can be implemented as part of the controller **1936** (as will be discussed below with reference to FIG. **20**), or as a separate block as shown in FIG. **19**. The current-limiter **1950** provides the current-control-signal $I_{CONTROL}$ **1918** as the target-current-control-signal I_{TARGET}

limited to a max-current-control-value I_{MAX} 1952, in the same way as discussed above.

The circuit 1900 further includes a clamp-circuit 1974, which is configured to set the control-voltage V_C 1956 to a clamp-voltage-value when the current-limiter 1950 provides the current-control-signal $I_{CONTROL}$ having the limited value of the max-current-control-value I_{MAX} 1952. Optional feedback from the current-limiter 1950 to the clamp-circuit 1974 is shown schematically as a dashed line in FIG. 19. The clamp-circuit 1974 can directly or indirectly set the control-voltage V_C 1956 the clamp-voltage-value; for example by affecting/controlling one or more components in the output voltage control loop, as will be described in more detail below.

The clamp-circuit 1974 can advantageously enable the circuit 1900 to quickly return to a normal operating mode after a heavy load current step in which the current-control-signal $I_{CONTROL}$ 1918 is limited. This can reduce the drift of the control-voltage V_C 1956 (especially when the controller 1936 includes an integrator). Therefore, the voltage overshoot in the output-voltage V_{OUT} of the SMPS 1901 can be reduced. In some examples, the overshoot in the output-voltage V_{OUT} in the case of a recovery after a current limiting situation is not higher than recovery in the case without current limiting.

The clamp-voltage-value may be the value of the control-voltage V_C 1956 when current limiting begins. In this way, if the max-current-control-value I_{MAX} 1952 is adjustable, then advantageously the associated clamp level can also automatically vary with this setting. Alternatively, the clamp-voltage-value may be a predetermined value that enables the controller 1936 to adequately return to a normal operating mode after current limiting has stopped. If a constant, predetermined value is used, then in some applications it should be set at a level that corresponds to the level for the highest possible setting for the max-current-control-value I_{MAX} 1952. In this way, the clamp-voltage-value should not limit the range for the adjustable maximum current I_{MAX} 1952.

The control-voltage V_C 1956 may be:

- (i) based on the difference between (a) the sense-voltage V_{SH} 1938, and (b) the reference-voltage V_{REF} 1942, when the resultant control-voltage V_C 1956 would produce a target-current-control-signal I_{TARGET} 1954 that is less than or equal to the max-current-control-value I_{MAX} 1952; and
- (ii) fixed as the clamp-voltage-value when: the difference between (a) the sense-voltage V_{SH} 1938, and (b) the reference-voltage V_{REF} 1942 would produce a target-current-control-signal I_{TARGET} 1954 that is greater than the max-current-control-value I_{MAX} 1952.

The example of the controller 1936 shown in FIG. 19 includes two sub-processing blocks 1943, 1944. The first sub-processing block 1943 processes the sense-voltage V_{SH} 1938 and the reference-voltage V_{REF} 1942, in order to provide the control-voltage V_C 1956. The second sub-processing block 1944 processes the control-voltage V_C 1956, in order to generate the target-current-control-signal I_{TARGET} 1954. One or both of the sub-processing blocks 1943, 1944 may be implemented as transconductance-amplifier-control-blocks.

FIG. 20 shows an example embodiment of a transconductance-amplifier-control-block 2044 that provides the functionality of the second sub-processing block, the current-limiter, and the clamp-circuit of FIG. 19. In this example, the current-control-signal $I_{CONTROL}$ of FIG. 19 is implemented as a peak-current-control-signal I_{PEAK} 2018

The transconductance-amplifier-control-block 2044 is configured to receive the control-voltage V_C 2056; prevent the control-voltage V_C 2056 from increasing when the peak-current-control-signal I_{PEAK} 2018 has the limited value of the max-current-control-value I_{MAX} 2052; and convert the control-voltage V_C 2056 to the peak-current-control-signal I_{PEAK} .

Components of FIG. 20 that have already been described with reference to FIG. 14 have been given corresponding reference numbers in the 2000 series, and will not necessarily be described again here.

The clamp-circuit 2074 includes: a bias-voltage-source 2076; a voltage amplifier, which in this example is an opamp 2078; and a clamp-transistor MN2 2080. In this example, the clamp-circuit 2074 also includes an optional clamp-switch MN4 2082 that can be used to selectively enable or disable the functionality of the clamp-circuit 2074.

The clamp-circuit 2074 can be considered as a voltage regulator, in that it can regulate the control-voltage V_C to the clamp-voltage-value, for all values V_{SH} and V_{REF} that would cause I_{TARGET} to be set to a value that is equal to or greater than the max-current-control-value I_{MAX} 2052. That is, once the control-voltage V_C (received from a preceding component in the controller) reaches a value where current limiting starts, any subsequent increases to the control-voltage V_C , that would be expected due to a mismatch between V_{SH} and V_{REF} , do not occur because the control-voltage V_C is regulated by the clamp-circuit 2074. In this way, the SMPS is not further controlled in an attempt to reduce the difference between V_{SH} and V_{REF} . This is because the difference between V_{SH} and V_{REF} cannot be further reduced due to the current limiting that is performed by the current-limiter.

The opamp 2078 has a first-opamp-input-terminal and a second-opamp-input-terminal. The first-opamp-input-terminal receives a bias-voltage-signal V_{BIAS} from the bias-voltage-source 2076. The bias-voltage-signal V_{BIAS} may also be referred to as a saturation voltage because it is used to determine whether or not a transistor has entered a saturation region, as will be discussed below. The second-opamp-input-terminal receives a current-limited-indicator-signal. The current-limited-indicator-signal is indicative of whether or not the peak-current-control-signal I_{PEAK} 2018 is set to the max-current-control-value I_{MAX} 2052. The opamp has an opamp-output-terminal that is connected to a control terminal of the clamp-transistor MN2 2080. The conduction channel or the clamp-transistor MN2 2080 is connected in series between the control terminal of the input-transistor MN1 2068 and ground.

In this example, the second-opamp-input-terminal is connected to the drain of the first-mirror-second-transistor MN3B 2064. As discussed above with reference to FIG. 14, when the peak-current-control-signal I_{PEAK} 2018 is set to the max-current-control-value I_{MAX} 2052, the first-mirror-second-transistor MN3B 2064 goes into a saturation region. When the first-mirror-second-transistor MN3B 2064 is in the saturate region, the voltage at its drain increases, thereby increasing the voltage at the second-opamp-input-terminal. The bias-voltage-signal V_{BIAS} can have a value that corresponds to the drain-source saturation voltage of the first-mirror-second-transistor MN3B 2064 ($V_{DS,SAT,MN3B}$). When the voltage at the second-opamp-input-terminal exceeds the bias-voltage-signal V_{BIAS} that is received at the first-opamp-input-terminal, the opamp 2078 controls the clamp-transistor 2080 such that the control-voltage V_C at the control terminal of the clamp-transistor MN2 2080 is clamped at the clamp-voltage-value. This therefore causes the peak-current-control-signal to have a value of I_{MAX} .

In this way, the clamp-circuit **2074** can detect when current limiting is being performed by comparing the drain voltage of the first-mirror-second-transistor MN3B **2064** with a bias-voltage that is equal to $V_{DS,SAT,MN3B}$. Then, as soon as current limiting occurs, the drain voltage of the first-mirror-second-transistor MN3B **2064** will exceed V_{BIAS} , and the opamp **2078** in combination with the clamp-transistor MN2 **2080** can regulate the voltage drop across the first-mirror-second-transistor MN3B **2064** to the saturation-voltage provided by the bias-voltage-source **2076**. That is, the clamp-circuit **2074** can prevent the control-voltage V_C **2056** from increasing when a transistor (such as the first-mirror-second-transistor MN3B **2084**) is in saturation. In some examples, saturation can be identified by the voltage drop across the transistor exceeding a saturation-voltage of the transistor.

In this example, the clamp-circuit **2074** is configured to provide a flag-signal **2086** that is representative of whether or not the control-voltage V_C is set to the clamp-voltage-value (which in this example is the last value of the control-voltage V_C before current limiting started). To this end, the clamp-circuit **2074** includes a clamp-comparator **2084** that compares the bias-voltage-signal V_{BIAS} with the current-limited-indicator-signal and sets the flag-signal **2086** to a value that is representative of clamping when the current-limited-indicator-signal is greater than the bias-voltage-signal V_{BIAS} .

In some applications, the clamp-circuit **2074** can pass the flag-signal **2086** to a controllable-block that if configured to be automatically controlled based on the flag-signal **2086**. For instance, an audio amplifier circuit may include a controllable-block that is configured to be automatically controlled based on the flag-signal **2086**. The controllable-block may comprise an amplifier, and the amplifier can automatically control an audio level of an output signal of the audio amplifier circuit based on the flag-signal. The audio amplifier may be a class-D audio amplifier. For example, the amplifier can automatically reduce an audio level of the output signal of the audio amplifier circuit when the flag-signal **2086** indicates that the control-voltage V_C is clamped. This can be on the basis that voltage clamping occurs when the volume is too high and can be damaging to the ears of listeners and/or in order to avoid excessive power consumption and/or to avoid high distortion of the audio signal when the supply voltage for the amplifier V_{BST} is not high enough when clamping occurs.

In some examples, a cascode (not shown) can be provided in series with the first current mirror **2061** in order to advantageously increase the accuracy of the first current mirror **2061**.

FIGS. **21** to **24** show plots of signals for the circuit of FIG. **19**, where the SMPS is implemented as a boost converter in the same way as FIG. **13**.

FIG. **21** shows three plots of output-voltage V_{BST} versus time;

- a first plot **2103** that corresponds to a load step-up and step-down that does not result in current limiting;
- a second plot **2105** that corresponds to a load step-up and step-down for the circuit of FIG. **13**, that is a load step that does result in current limiting but is for a circuit that does not have voltage clamping; and
- a third plot **2106** that corresponds to a load step-up and step-down for the circuit of FIG. **19**, that is a load step that does result in current limiting and is for a circuit that does have voltage clamping.

A comparison of the second and third plots **2105**, **2106** shows that use of the control-voltage clamping advantageously reduces the overshoot in the output-voltage V_{BST} .

FIG. **22** shows the inductor current I_L during a load step-up and step-down, where both current limiting and voltage clamping are used.

FIG. **23** shows three plots of the control-voltage V_C versus time;

- a first plot **2307** that correspond to a load step-up and step-down that does not result in current limiting; and
- a second plot **2309** that corresponds to a load step-up and step-down for the circuit of FIG. **13**, that is a load step that does result in current limiting but is for a circuit that does not have voltage clamping; and
- a third plot **2310** that corresponds to a load step-up and step-down for the circuit of FIG. **19**, that is a load step that does result in current limiting and is for a circuit that does have voltage clamping.

FIG. **23** shows that the control-voltage V_C does not significantly drift away from its normal operation value while the current is being limited.

FIG. **24** shows a plot of the flag-signal that is representative of whether or not the control-voltage V_C is set to the clamp-voltage-value.

FIG. **25** shows an example embodiment of the transconductance-amplifier-control-block of FIG. **20**, which provides the functionality of the second sub-processing block, the current-limiter, and the clamp-circuit of FIG. **19**. In particular, further details of the clamp-circuit **2574** are included in FIG. **25**. The opamp of FIG. **20** is constructed with a differential matched pair (MP3A and MP3B) and two bias current sources. The comparator in FIG. **20**, which generates the flag-signal **2586**, is built with: a transistor MN5, a bias current source and an inverter.

FIG. **25** also shows the bias-voltage-source **2576** of FIG. **20**.

FIG. **26** shows an example embodiment of a transconductance-amplifier-control-block, which is similar to that of FIG. **25**. In FIG. **26**, the functionality of the voltage source V_{BIAS} of FIG. **25** has been replaced by a systematic offset on the input of the opamp by choosing different sizes of the input-transistors MP3A **2692** and MP3B **2690**.

FIG. **27** shows another example embodiment of a circuit **2700** that includes a SMPS **2701** and a controller **2736**. In this example, the SMPS **2701** is a boost converter. Features of FIG. **27** that are shown in either of FIG. **13** or **19** have been given corresponding reference numbers in the **2700** series, and will not necessarily be described again here.

The controller **2736** incorporates the functionality of a current-limiter **2750** in the same way as discussed above. The controller **2736** also incorporates the functionality of a clamp-circuit, although in this example the clamp-circuit indirectly sets the control-voltage V_C **2756** to a clamp-voltage-value. As will be discussed in more detail with reference to FIG. **28**, the controller **2736** can provide a non-zero over-current-signal I_{OC} **2794** when the current-control-signal I_{PEAK} **2718** has the limited value of I_{MAX} **2752**. The over-current-signal I_{OC} **2794** is configured to increase V_{SH} independently of the current through the boost converter **2701**, thereby effectively lowering the set-point for the boost voltage to a different level that is low enough to maintain the load current with $I_{PEAK}=I_{MAX}$.

The boost converter **2701** includes: a sense-resistor R_{SH} **2740**, which is configured to provide the sense-voltage V_{SH} **2738** to the controller **2736**; and a programmable current source **2737** which provides a current I_{SET} through the sense-resistor R_{SH} **2740**. In this example, because the over-

current-signal I_{OC} 2794 is also provided to the sense-resistor R_{SH} 2740, the sense-voltage V_{SH} 2738 is equal to:

$$V_{SH} = V_{BST} - R_{SH}(I_{SET} - I_{OCP}), \text{ where}$$

$$I_{SET} = \frac{(V_{BST,TARGET} - V_{REF})}{R_{SH}} \text{ and consequently,}$$

$$V_{SH} = V_{BST} - (V_{BST,TARGET} - R_{SH}I_{OCP}) + V_{REP}$$

Therefore, a non-zero, positive, value for the over-current-signal I_{OC} 2794 effectively decreases $V_{BST,TARGET}$ with $R_{SH} * I_{OCP}$ which causes V_{BST} 2738 to decrease while keeping V_{SH} constant and also keeping the error voltage $V_{REF} - V_{SH}$ constant. $V_{BST,TARGET}$ can be referred to as a target-output-voltage.

In FIG. 27, the voltage across the sense resistor R_{SH} 2740 is clamped using the over-current-signal I_{OC} 2794. This has the knock-on effect of (indirectly) clamping the control-voltage V_C 2766. Under normal operating conditions, when the target-current-control-signal I_{TARGET} 1954 is below the maximum current level and therefore is not being limited, the over-current-signal I_{OC} 2794 is zero. However, when current limiting occurs, the over-current-signal I_{OC} 2794 will increase to limit the voltage across the sense resistor R_{SH} 2740. The net effect is that the target boost voltage $V_{BST,TARGET}$ is reduced with $R_{SH} * I_{OCP}$. Instead of regulating the boost voltage using the inductor current I_L 2714 as is done under normal operating conditions, now the inductor current I_L 2714 is regulated to the maximum level using the boost voltage. Since the loop provided by the controller 2736 is still in control, the error voltage will be small and the control-voltage (integrated error voltage) V_C 2756 will not drift away.

In the same way as FIG. 19, the controller 2736 of FIG. 27 includes a second sub-processing block 2744 that processes the control-voltage V_C 2756 in order to generate the target-current-control-signal I_{TARGET} 2754.

FIG. 28 shows an example implementation of the second sub-processing block of FIG. 27, which to this example is a transconductance-amplifier-control-block 2844. Features of the transconductance-amplifier-control-block 2844 that have already been described with reference to FIG. 14, 20, 25 or 26 will not necessarily be described again here.

The transconductance-amplified-control-block 2844 incorporates the functionality of the current-limiter and the clamp-circuit such that the transconductance-amplifier-control-block 2844 is configured to: receive the control-voltage V_C 2856, and provide a non-zero over-current-signal I_{OC} 2894 when the current-control-signal I_{PEAK} 2518 has the limited value of I_{MAX} 2852. As discussed above, the over-current-signal I_{OC} 2894 is configured to change the boost voltage $V_{BST,TARGET}$ independently of the current through the switched-mode-power-supply. The transconductance-amplifier-control-block 2844 also converts the control-voltage V_C 2856 to the current-control-signal I_{PEAK} 2818.

One or more of the examples disclosed herein can be used with any current mode controlled DC-DC converter, and especially those with an integrating voltage control loop.

The instructions and/or flowchart steps in the above figures can be executed in any order, unless a specific order is explicitly stated. Also, those skilled in the art will recognize that while one example set of instructions/method has been discussed, the material in this specification can be

combined in a variety of ways to yield other examples as well, and are to be understood within a context provided by this detailed description.

In some example embodiments the set of instructions/method steps described above are implemented as functional and software instructions embodied as a set of executable instructions which are effected on a computer or machine which is programmed with and controlled by said executable instructions. Such instructions are loaded (or execution on a processor (such as one or more CPUs). The term processor includes microprocessors, microcontrollers, processor modules or subsystems (including one or more microprocessors or microcontrollers), or other control or computing devices. A processor can refer to a single component or to plural components.

In other examples, the set of instructions/methods illustrated herein and data and instructions associated therewith are stored in respective storage devices, which are implemented as one or more non-transient machine or computer-readable or computer-usable storage media or mediums. Such computer-readable or computer usable storage medium of media is (are) considered to be part of an article (or article of manufacture). An article or article of manufacture can refer to any manufactured single component or multiple components. The non-transient machine or computer usable media or mediums as defined herein excludes signals, but such media or mediums may be capable of receiving and processing information from signals and/or other transient mediums.

Example embodiments of the material discussed in this specification can be implemented in whole or in part through network, computer, or data based devices and/or services. These may include cloud, internet, intranet, mobile, desktop, processor, look-up table, microcontroller, consumer equipment, infrastructure, or other enabling devices and services. As may be used herein and in the claims, the following non-exclusive definitions are provided.

In one example, one or more instructions or steps discussed herein are automated. The terms automated or automatically (and like variations thereof) mean controlled operation of an apparatus, system, and/or process using computers and/or mechanical/electrical devices without the necessity of human intervention, observation, effort and/or decision.

It will be appreciated that any components said to be coupled may be coupled or connected either directly or indirectly. In the case of indirect coupling, additional components may be located between the two components that are said to be coupled.

In this specification, example embodiments have been presented in terms of a selected set of details. However, a person of ordinary skill in the art would understand that many other example embodiments may be practiced which include a different selected set of these details. It is intended that the following claims cover all possible example embodiments.

The invention claimed is:

1. A circuit for a switched-mode-power-supply, wherein the switched-mode-power-supply is configured to: receive a current-control-signal; and provide an output-voltage based on the current-control-signal, the circuit comprising:

a controller, configured to:

generate a control-voltage based on a difference between: (i) a sense-voltage, which is representative of the output-voltage of the switched-mode-power-supply; and (ii) a reference-voltage;

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generate a target-current-control-signal based on the control-voltage, wherein the target-current-control-signal is configured to adjust a current through the switched-mode-power-supply in order to bring a magnitude of the sense-voltage closer to a magnitude of the reference-voltage;

a current-limiter configured to provide the current-control-signal as the target-current-control-signal limited to a max-current-control-value; and

a clamp-circuit configured to set the control-voltage to a clamp-voltage-value when the current-limiter provides the current-control-signal having the limited value of the max-current-control-value;

wherein the controller includes a transconductance-amplifier-control-block, which incorporates a functionality of the current-limiter and the clamp-circuit such that the transconductance-amplifier-control-block is configured to:

receive the control-voltage;

prevent the control-voltage from increasing when the current-control-signal has the limited value of the max-current-control-value; and

convert the control-voltage to the current-control-signal.

2. The circuit of claim 1, wherein the clamp-circuit comprises a voltage regulator, wherein the voltage regulator is configured to regulate the control-voltage to the clamp-voltage-value for all values of the sense-voltage and the reference-voltage that would cause the target-current-control-signal to be set to a value that is equal to or greater than the max-current-control-value.

3. The circuit of claim 1, wherein the transconductance-amplifier-control-block comprises:

a voltage amplifier,

a bias-voltage-source configured to provide a saturation-voltage;

a clamp-transistor; and

a first-mirror-second-transistor;

wherein the voltage amplifier in combination with the clamp-transistor is configured to regulate the voltage drop across the first-mirror-second-transistor to the saturation-voltage provided by the bias-voltage-source.

4. The circuit of claim 1, wherein:

the transconductance-amplifier-control-block comprises an additional transistor, and

the transconductance-amplifier-control-block is configured to prevent the control-voltage from increasing when the voltage drop across the transistor exceeds a saturation-voltage of the transistor.

5. The circuit of claim 3, wherein the saturation-voltage is representative of the additional transistor being in a saturated state of operation.

6. The circuit of claim 1, wherein the transconductance-amplifier-control-block is configured prevent the control-voltage from increasing when a transistor in the transconductance-amplifier-control-block is in saturation.

7. The circuit of claim 1, wherein the controller comprises:

the transconductance-amplifier-control-block, which incorporates the functionality of the current-limiter and the clamp-circuit such that the transconductance-amplifier-control-block is configured to:

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receive the control-voltage;

provide a non-zero over-current-signal when the current-control-signal has the limited value of max-current-control-value,

wherein the over-current-signal is configured to change the sense-voltage independently of the current through the switched-mode-power-supply; and

convert the control-voltage to the current-control-signal.

8. The circuit of claim 1, wherein the clamp-voltage-value is a value of the control-voltage before the current-limiter provides the current-control-signal with the limited value of the max-current-control-value.

9. The circuit of claim 8, wherein the clamp-circuit is configured to clamp the control-voltage to a current value when the current-limiter provides the current-control-signal with the limited value of the max-current-control-value.

10. The circuit of claim 1, wherein the controller is configured to generate the control-voltage by integrating the difference between: (i) the sense-voltage; and (ii) the reference-voltage.

11. The circuit of claim 1, wherein the target-current-control-signal is configured to adjust the current through the switched-mode-power-supply by setting the peak current through an inductor in the switched-mode-power-supply.

12. The circuit of claim 1, wherein:

the clamp-circuit is configured to provide a flag-signal that is representative of whether or not the control-voltage is set to the clamp-voltage-value; and

the circuit comprises a controllable-block that is configured to be automatically controlled based on the flag-signal.

13. An audio amplifier circuit comprising:

the circuit of claim 1,

wherein the clamp-circuit is configured to provide a flag-signal that is representative of whether or not the control-voltage is set to the clamp-voltage-value; and

a controllable-block that is configured to be automatically controlled based on the flag-signal.

14. The audio amplifier circuit of claim 13, wherein the controllable-block comprises an amplifier, and wherein the amplifier is configured to automatically control an audio level of an output signal of the audio amplifier circuit based on the flag-signal.

15. A circuit for a switched-mode-power-supply, wherein the switched-mode-power-supply is configured to: receive a current-control-signal; and provide an output-voltage based on the current-control-signal, the circuit comprising:

a controller, configured to:

generate a control-voltage based on a difference between: (i) a sense-voltage, which is representative of the output-voltage of the switched-mode-power-supply; and (ii) a reference-voltage;

generate a target-current-control-signal based on the control-voltage, wherein the target-current-control-signal is configured to adjust a current through the switched-mode-power-supply in order to bring a magnitude of the sense-voltage closer to a magnitude of the reference-voltage;

a current-limiter configured to provide the current-control-signal as the target-current-control-signal limited to a max-current-control-value; and

a clamp-circuit configured to set the control-voltage to a clamp-voltage-value when the current-limiter provides

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the current-control-signal having the limited value of the max-current-control-value;

wherein the controller includes a transconductance-amplifier-control-block, which incorporates a functional-
 ity of the current-limiter and the clamp-circuit such that
 the transconductance-amplifier-control-block is config-
 5 ured to:
 receive the control-voltage;
 provide a non-zero over-current-signal when the cur-
 rent-control-signal has the limited value of max-
 10 current-control-value,
 wherein the over-current-signal is configured to change
 the sense-voltage independently of the current
 through the switched-mode-power-supply; and
 convert the control-voltage to the current-control-sig-
 15 nal.

16. A circuit for a switched-mode-power-supply, wherein
 the switched-mode-power-supply is configured to: receive a
 current-control-signal; and provide an output-voltage based
 on the current-control-signal, the circuit comprising:
 20 a controller, configured to:
 generate a control-voltage based on a difference
 between: (i) a sense-voltage, which is representative
 of the output-voltage of the switched-mode-power-
 supply; and (ii) a reference-voltage;

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generate a target-current-control-signal based on the
 control-voltage, wherein the target-current-control-
 signal is configured to adjust a current through the
 switched-mode-power-supply in order to bring a
 magnitude of the sense-voltage closer to a magnitude
 of the reference-voltage;

a current-limiter configured to provide the current-con-
 trol-signal as the target-current-control-signal limited
 to a max-current-control-value; and

a clamp-circuit configured to set the control-voltage to a
 clamp-voltage-value when the current-limiter provides
 the current-control-signal having the limited value of
 the max-current-control-value;

wherein the circuit is included in an audio amplifier
 circuit;

wherein the clamp-circuit is configured to provide a
 flag-signal that is representative of whether or not the
 control-voltage is set to the clamp-voltage-value; and a
 controllable-block that is configured to be automati-
 cally controlled based on the flag-signal;

wherein the controllable-block comprises an amplifier,
 and wherein the amplifier is configured to automati-
 cally control an audio level of an output signal of the
 audio amplifier circuit based on the flag-signal.

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